

# Intel® NUC Board NUC5CPYB and Intel® NUC Board NUC5PPYB

**Technical Product Specification** 

October 2016 Order Number: H71812-0011

### Intel NUC Board NUC5CPYB and Intel NUC Board NUC5PPYB Technical Product Specification

The Intel NUC Board NUC5CPYB and Intel NUC Board NUC5PPYB may contain design defects or errors known as errata that may cause the product to deviate from published specifications. Current characterized errata are documented in the Intel NUC Board NUC5CPYB and Intel NUC Board NUC5PPYB Specification Update.

# **Revision History**

Revision	Revision History	Date
001	First release of the Intel® NUC Board NUC5CPYB and Intel NUC Board NUC5PPYB Technical Product Specification	May 2015
002	Specification Clarification	June 2015
003	Specification Clarification	June 2015
004	Specification Clarification	August 2015
005	Specification Clarification	September 2015
006	Specification Clarification	October 2015
007	Specification Clarification	March 2016
008	Specification Change	May 2016
009	Specification Clarification	June 2016
0010	Specification Change	August 2016
0011	Specification Change	October 2016

### Disclaimer

This product specification applies to only the standard Intel® NUC Board with BIOS identifier PYBSW10H.86A

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### **Board Identification Information**

### Basic Intel® NUC Board NUC5CPYB Identification Information

AA Revision	BIOS Revision	Notes
H61145-4xx	PYBSW10H.86A.00xx	1,2

### Notes:

- 1. The AA number is found on a small label on the component side of the board.
- 2. Intel® Celeron® processor N3050, used on this AA revision, consists of the following component:

Device	Stepping	S-Spec Numbers	
Intel Celeron processor N3050	СО	SR2A9	

### Basic Intel® NUC Board NUC5PPYB Identification Information

AA Revision	BIOS Revision	Notes
H76559-1xx	PYBSW10H.86A.00xx	1,2

### Notes:

- 1. The AA number is found on a small label on the component side of the board.
- 2. Intel® Pentium® processor N3700, used on this AA revision, consists of the following component:

Device	Stepping	S-Spec Numbers
Intel Pentium processor N3700	CO	SR29E

# **Specification Changes or Clarifications**

The table below indicates the Specification Changes or Specification Clarifications that apply to the Intel NUC Board NUC5CPYB and NUC5PPYB.

### **Specification Changes or Clarifications**

Date	Type of Change	Description of Changes or Clarifications
June 2015	Spec Clarification	Updated Section 3.9 to show the correct password length.
June 2015	Spec Clarification	Updated Sections 1.5.1.1 and 1.5.1.3 with correct data.
August 2015	Spec Clarification	Updated Section 2.2.4.3 with a Note regarding the SD card reader.
September 2015	Spec Clarification	Added a note regarding memory speed to Table 1.
October 2015	Spec Clarification	Removed all reference to the Front Panel Header as it was not stuffed on the board.
Mach 2016	Spec Clarification	Added a Note to Section 2.2.4.4 to clarify what the Auxiliary Power Connector is used for.
May 2016	Spec Change	<ul> <li>Deleted the Near Field Communication (NFC) header and all related text.</li> <li>Added Section 2.2.4.5 Front Panel Header.</li> </ul>
June 2016	Spec Clarification	Updated SATA speed to 6.0 Gb/s.
August 2016	Spec Change	<ul> <li>Added section 1.5.1.4 Analog Display (VGA)</li> <li>Added information to 1.5.1.1 Intel® High Definition (Intel® HD) Graphics</li> <li>In section 1.11.1 Hardware Monitoring, changed to ITE IT8607D</li> </ul>
October 2016	Spec Change	Added information about supported SD Cards, 8 GB to 128 GB, to SDXC Card Reader section

# **Errata**

Current characterized errata, if any, are documented in a separate Specification Update. See <a href="http://www.intel.com/content/www/us/en/nuc/overview.html">http://www.intel.com/content/www/us/en/nuc/overview.html</a> for the latest documentation.

# **Preface**

This Technical Product Specification (TPS) specifies the board layout, components, connectors, power and environmental requirements, and the BIOS for Intel® NUC Board NUC5CPYB and Intel® NUC Board NUC5PPYB.

### **Intended Audience**

The TPS is intended to provide detailed technical information about Intel NUC Board NUC5CPYB and Intel NUC Board NUC5PPYB and its components to the vendors, system integrators, and other engineers and technicians who need this level of information. It is specifically not intended for general audiences.

### What This Document Contains

Chapter	Description
1	A description of the hardware used on Intel NUC Board NUC5CPYB and Intel NUC Board NUC5PPYB
2	A map of the resources of the Intel NUC Board
3	The features supported by the BIOS Setup program
4	A description of the BIOS error messages, beep codes, and POST codes
5	Regulatory compliance and battery disposal information

# **Typographical Conventions**

This section contains information about the conventions used in this specification. Not all of these symbols and abbreviations appear in all specifications of this type.

# Notes, Cautions, and Warnings



### NOTE

Notes call attention to important information.



# **A** CAUTION

Cautions are included to help you avoid damaging hardware or losing data.

# **Other Common Notation**

#	Used after a signal name to identify an active-low signal (such as USBPO#)
GB	Gigabyte (1,073,741,824 bytes)
GB/s	Gigabytes per second
Gb/s	Gigabits per second
КВ	Kilobyte (1024 bytes)
Kb	Kilobit (1024 bits)
kb/s	1000 bits per second
МВ	Megabyte (1,048,576 bytes)
MB/s	Megabytes per second
Mb	Megabit (1,048,576 bits)
Mb/s	Megabits per second
TDP	Thermal Design Power
xxh	An address or data value ending with a lowercase h indicates a hexadecimal value.
x.x V	Volts. Voltages are DC unless otherwise specified.
*	This symbol is used to indicate third-party brands and names that are the property of their respective owners.

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# 1 Product Description

# 1.1 Overview

# 1.1.1 Feature Summary

Table 1 summarizes the major features of the board.

Table 1. Feature Summary

Form Factor	Factor 4.0 inches by 4.0 inches (101.60 millimeters by 101.60 millimeters)				
Processor	Soldered-down dual-core Intel® Celeron® processor N3050 with up to 6 W TDP     Integrated graphics     Integrated memory controller     Integrated PCH     Soldered-down quad-core Intel® Pentium® processor N3700 with up to 6 W TDP     Integrated graphics     Integrated memory controller     Integrated PCH				
Memory	Support for DDR3L 1333/1600 MHz SO-DIMMs				
	Support for 1066 MHz/1666 MHz memory speeds				
	Note: If you install 1333 MHz, it will run at 1066 MHz.				
	Support for 1 Gb, 2 Gb, and 4 Gb memory technology				
	Support for up to 8 GB of system memory with one SO-DIMM using 4 Gb memory technology				
	Support for non-ECC memory				
	Support for 1.35 V low voltage JEDEC memory				
Graphics	Integrated graphics support with Intel® Graphics Technology:     High Definition Multimedia Interface* (HDMI*)     VGA				
Audio	Intel® High Definition (Intel® HD) Audio via the HDMI v1.4b interface through the processor				
	Realtek HD Audio via a stereo microphone/headphone 3.5 mm jack on the front panel				
	Compressed 5.1/7.1 digital audio through a mini-TOSLINK jack on the back panel				
Peripheral Interfaces	USB 3.0 ports:				
	<ul> <li>Two ports are implemented with external front panel connectors (one blue and one orange charging capable)</li> <li>Two ports are implemented with external back panel connectors (blue)</li> <li>USB 2.0 ports:</li> </ul>				
	<ul> <li>Two ports via one dual-port internal 1x8 1.25 mm pitch header (white)</li> <li>One port is reserved for an M.2 2230 Type E Module</li> <li>Consumer Infrared (CIR)</li> </ul>				
Storage	One SATA 6.0 Gb/s port (black)				
	<ul> <li>Supports one 2.5" SSD or HDD up to 9.5mm</li> <li>One full sized SDXC slot</li> </ul>				

continued

Table 1. Feature Summary (continued)

Expansion Capabilities	One M.2 Module supporting M.2 2230 cards (key type E)	
BIOS	Intel® BIOS resident in the Serial Peripheral Interface (SPI) Flash device	
	Support for Advanced Configuration and Power Interface (ACPI), Plug and Play, and System Management BIOS (SMBIOS)	
LAN Support  Gigabit (10/100/1000 Mb/s) LAN subsystem using the Realtek* 8111HN Giga Controller		
Hardware Monitor	Hardware monitoring subsystem, based on an ITE IT8607D embedded controller, including:	
Subsystem	Voltage sense to detect out of range power supply voltages	
	Thermal sense to detect out of range thermal values	
	One processor fan header	
	Fan sense input used to monitor fan activity	
	Simple fan speed control	
Wireless	Intel® Dual Band Wireless-AC 3165 module	
	2nd Gen 802.11ac, Dual Band, 1x1 Wi-Fi + Dual Mode Bluetooth 4.0	
	Maximum Transfer speed up to 433Mbps	
	Supports Intel® Wireless Display (WiDi)	
	Supports Intel® Smart Connect Technology	
	Pre-installed in M.2 2230 slot	

# 1.1.2 Board Layout (Top)

Figure 1 shows the location of the major components on the top-side of Intel NUC Board NUC5CPYB and Intel NUC Board NUC5PPYB.

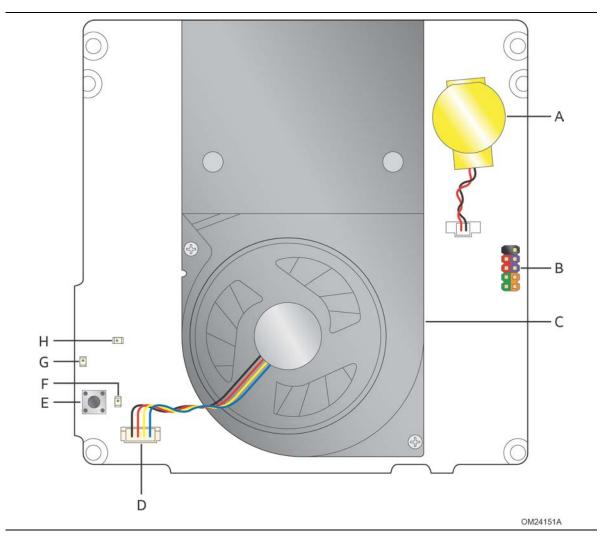


Figure 1. Major Board Components (Top)

Table 2 lists the components identified in Figure 1.

Table 2. Components Shown in Figure 1

Item from Figure 1	Description
A	Battery
В	Front panel header
С	Thermal solution
D	Processor fan header
E	Onboard power button
F	Power LED
G	Hard Disk Drive LED
Н	Standby Power LED

# 1.1.3 Board Layout (Bottom)

Figure 2 shows the location of the major components on the bottom-side of Intel NUC Board NUC5CPYB and Intel NUC Board NUC5PPYB.

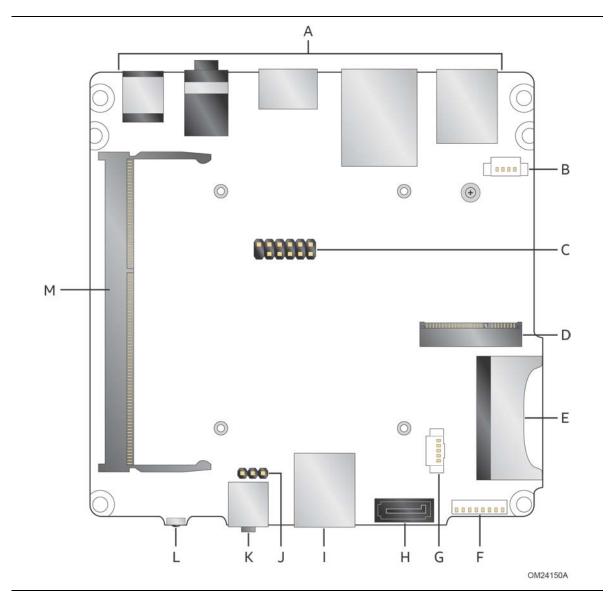


Figure 2. Major Board Components (Bottom)

Table 3. Components Shown in Figure 2

Item from Figure 2	Description
A	Back panel connectors
В	Auxiliary power connector (1.25 mm pitch)
С	VGA connector
D	M.2 2230 Module connector
E	SDXC slot
F	Front panel dual-port USB 2.0 header (1.25 mm pitch)
G	SATA power connector (1.25 mm pitch)
Н	SATA 6.0 Gb/s connector
I	Front panel USB 3.0 connectors (one blue and one orange charging capable)
J	BIOS security jumper
K	Front panel stereo microphone/headphone jack
L	Front panel Consumer Infrared sensor (CIR)
М	DDR3L SO-DIMM socket

# 1.1.4 Block Diagram

Figure 3 is a block diagram of the major functional areas of the board.

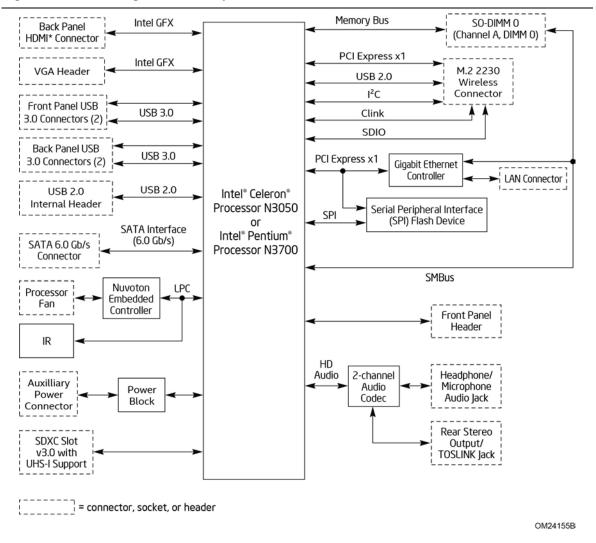


Figure 3. Block Diagram

# 1.2 Online Support

To find information about... Visit this World Wide Web site:

Intel NUC Board NUC5CPYB and Intel NUC Board <a href="http://www.intel.com/NUC">http://www.intel.com/NUC</a>

**NUC5PPYB** 

NUC Board Support <a href="http://www.intel.com/NUCSupport">http://www.intel.com/NUCSupport</a>

Available configurations for Intel NUC Board NUC5CPYB <a href="http://ark.intel.com">http://ark.intel.com</a>

and Intel NUC Board NUC5PPYB

BIOS and driver updates

http://downloadcenter.intel.com

Tested memory

Integration information

http://www.intel.com/NUCSupport

http://www.intel.com/NUCSupport

### 1.3 Processor

Intel NUC Board NUC5CPYB has a soldered-down System-on-a-Chip (SoC), which consists of a dual-core Intel Celeron processor N3050 with up to 6 W TDP.

- Integrated graphics
- Integrated memory controller
- Integrated PCH

Intel NUC Board NUC5PPYB has a soldered-down System-on-a-Chip (SoC), which consists of a quad-core Intel Pentium processor N3700 with up to 6 W TDP.

- Integrated graphics
- · Integrated memory controller
- Integrated PCH



### NOTE

This board has specific requirements for providing power to the processor. Refer to Section 2.5.1 on page 55 for information on power supply requirements for this board.

# 1.4 System Memory

The board has one 204-pin SO-DIMM socket and supports the following memory features:

- 1.35 V DDR3L 1333/1600 MHz SDRAM SO-DIMM with gold plated contacts on Intel Celeron processor N3050 and Intel Pentium processor N3700
- One memory channel
- Unbuffered, single-sided or double-sided SO-DIMMs
- 8 GB maximum total system memory (with 4 Gb memory technology). Refer to Section 2.1.1 on page 39 for information on the total amount of addressable memory.
- Minimum recommended total system memory: 1024 MB
- Non-ECC SO-DIMMs
- Serial Presence Detect



### **NOTE**

To be fully compliant with all applicable DDR SDRAM memory specifications, the board should be populated with SO-DIMMs that support the Serial Presence Detect (SPD) data structure. This allows the BIOS to read the SPD data and program the chipset to accurately configure memory settings for optimum performance. If non-SPD memory is installed, the BIOS will attempt to correctly configure the memory settings, but performance and reliability may be impacted or the SO-DIMMs may not function under the determined frequency.

Table 4 lists the supported SO-DIMM configurations.

**Table 4. Supported Memory Configurations** 

SO-DIMM		SDRAM	SDRAM Organization	Number of SDRAM
Capacity	Configuration (Note)	Density	Front-side/Back-side	Devices
1024 MB	SS	1 Gbit	128 M x8/empty	8
2048 MB	DS	1 Gbit	128 M x8/128 M x8	16
2048 MB	SS	2 Gbit	256 M x8/empty	8
4096 MB	DS	2 Gbit	256 M x8/256 M x8	16
4096 MB	SS	4 Gbit	512 M x8/empty	8
8192 MB	DS	4 Gbit	512 M x8/512 M x8	16

Note: "DS" refers to double-sided memory modules (containing two rows of SDRAM) and "SS" refers to single-sided memory modules (containing one row of SDRAM).

For information about	Refer to:
Tested Memory	http://www.intel.com/NUCSupport



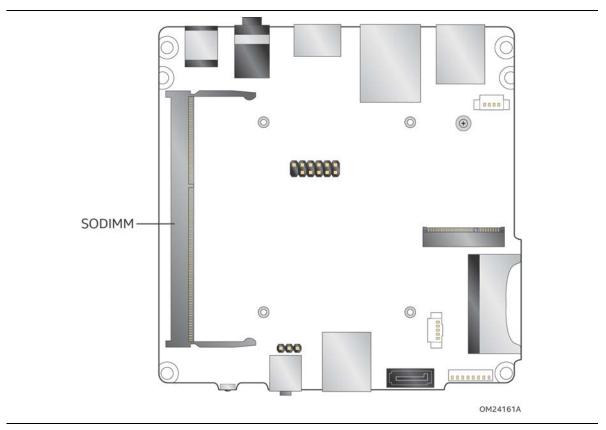


Figure 4. Memory Channel and SO-DIMM Configuration

# 1.5 Processor Graphics Subsystem

The board supports graphics through Intel HD Graphics.

### 1.5.1 Integrated Graphics

The board supports integrated graphics via the processor.

### 1.5.1.1 Intel® High Definition (Intel® HD) Graphics

The Intel HD graphics controller features the following:

- HDMI 1.4b supports resolutions up to 3840 x 2160 (4K UHD) at 30Hz or 2560 x 1600 (WQXGA) at 60Hz
- VGA (via an ITE IT6515FN DP to VGA bridge) supports resolutions up to 1920 x 1200 (WUXGA) at 60Hz
- Dual independent display support
- 3D graphics hardware acceleration supporting DirectX\*11.1, OpenCL\* 1.2, OGL ES Halti/2.0/1.1, OpenGL\* 4.2
- Video decode hardware acceleration supporting H.265/HEVC @ Level 5, H.264 @ Level 5.2, MPEG2, MVC, VC-1, WMV9, JPEG and VP8 formats
- Video encode hardware acceleration supporting H.264 @ Level 5.1, JPEG and MVC formats
- High-Bandwidth Digital Content Protection (HDCP) 1.4/2.2 support for content protection

### 1.5.1.2 Video Memory Allocation

Intel® Dynamic Video Memory Technology (DVMT) is a method for dynamically allocating system memory for use as graphics memory to balance 2D/3D graphics and system performance. If your computer is configured to use DVMT, graphics memory is allocated based on system requirements and application demands (up to the configured maximum amount). When memory is no longer needed by an application, the dynamically allocated portion of memory is returned to the operating system for other uses.

### 1.5.1.3 High Definition Multimedia Interface\* (HDMI\*)

The HDMI port supports standard, enhanced, or high definition video, plus multi-channel digital audio on a single cable. The port is compatible with all ATSC and DVB HDTV standards and supports eight full range channels at 24-bit/96 kHz audio of lossless audio formats. The maximum supported resolution is  $3840 \times 2160 \otimes 30 \text{ Hz}$  and  $2560 \times 1600 \otimes 60 \text{ Hz}$ , 24 bpp (WUXGA). The HDMI port is compliant with the HDMI 1.4b specification.

### 1.5.1.3.1 Integrated Audio Provided by the HDMI Interfaces

The following audio technologies are supported by the HDMI 1.4b interfaces directly from the SoC:

- AC3 Dolby\* Digital
- Dolby Digital Plus
- LPCM, 192 kHz/24-bit, 8 Channel

# 1.5.1.4 Analog Display (VGA)

The VGA port supports analog displays. The maximum supported resolution is  $1920 \times 1200$  (WUXGA) at a 60 Hz refresh rate

### 1.6 USB

The USB port arrangement is as follows:

- USB 3.0 ports:
  - Two ports are implemented with external front panel connectors (one blue and one orange charging capable)
  - Two ports are implemented with external back panel connectors (blue)
  - Maximum current is 900 mA for each blue port, 1.5 A for the orange charging port
- USB 2.0 ports:
  - Two ports via one dual-port internal 1x8 1.25 mm pitch header (white)
  - One port is reserved for an M.2 2230 Module
  - Maximum current is 500 mA for each port of the white header (1 A total)

All the USB ports are high-speed, full-speed, and low-speed capable.



### **NOTE**

Computer systems that have an unshielded cable attached to a USB port may not meet FCC Class B requirements, even if no device is attached to the cable. Use a shielded cable that meets the requirements for full-speed devices.

For information about	Refer to
The location of the USB connectors on the back panel	Figure 11, page 40
The location of the USB connector on the front panel	Figure 2, page 17

### 1.7 SATA Interface

The SoC provides one SATA port with a theoretical maximum transfer rate of 6.0 Gb/s. A point-to-point interface is used for host to device connections.

The underlying SATA functionality is transparent to the operating system. The SATA controller can operate in both legacy and native modes. In legacy mode, standard IDE I/O and IRQ resources are assigned (IRQ 14 and 15). In Native mode, standard PCI Conventional bus resource steering is used. Native mode is the preferred mode for configurations using Windows\* operating systems.

### 1.7.1 AHCI Mode

The board supports AHCI storage mode.



### NOTE

In order to use AHCI mode, AHCI must be enabled in the BIOS. Microsoft\* Windows 8 includes the necessary AHCI drivers without the need to install separate AHCI drivers during the operating

system installation process. However, it is always good practice to update the AHCI drivers to the latest available by Intel.

# 1.8 Real-Time Clock Subsystem

A coin-cell battery (CR2032) powers the real-time clock and CMOS memory. When the computer is not plugged into a wall socket, the battery has an estimated life of three years. When the computer is plugged in, the standby current from the power supply extends the life of the battery. The clock is accurate to  $\pm$  13 minutes/year at 25  $^{\circ}$ C with 3.3 VSB applied via the power supply 5 V STBY rail.



### **NOTE**

If the battery and AC power fail, date and time values will be reset and the user will be notified during the POST.

When the voltage drops below a certain level, the BIOS Setup program settings stored in CMOS RAM (for example, the date and time) might not be accurate. Replace the battery with an equivalent one. Figure 1 on page 15 shows the location of the battery.

# 1.9 Audio Subsystem

The board supports Intel HD Audio via the Realtek ALC283 audio codec. The audio subsystem supports the following features:

- Analog line-out/Analog Headphone/Analog Microphone jack on the front panel
- High Definition Audio via a stereo microphone/headphone jack on the back panel
- Support for 44.1 kHz/48 kHz/96 kHz/192 kHz sample rates on all analog outputs
- Support for 44.1 kHz/48 kHz/96 kHz sample rates on all analog inputs
- Back Panel Audio Jack Support (see Figure 5 for 3.5 mm audio jack pin out):
  - Speakers only
  - Headphones only
  - Microphone only
  - Combo Headphone/Microphone



Pin Number	Pin Name	Description
1	Tip	Left Audio Out
2	Ring	Right Audio Out
3	Ring	Common/Ground
4	Sleeve	Audio In

Figure 5. 4-Pin 3.5 mm (1/8 inch) Audio Jack Pin Out



### NOTE

The analog circuit of the back panel audio connector is designed to power headphones or amplified speakers only. Poor audio quality occurs if passive (nonamplified) speakers are connected to this output.

### 1.9.1 Mini-TOSLINK Interface

The 3.5 mm audio jack also provides TOSLINK optical digital audio output.

- Mini-TOSLINK interface (back panel) plus analog audio out
  - PCM datastream support
  - S/PDIF datastream support
  - Mini-TOSLINK adaptor necessary to connect to standard TOSLINK cable
  - Stereo audio out



Figure 6. Mini-TOSLINK Adaptor

# 1.9.2 Audio Subsystem Software

Audio software and drivers are available from Intel's World Wide Web site.

For information about	Refer to
Obtaining Audio software and drivers	http://downloadcenter.intel.com

# 1.10 LAN Subsystem

The LAN subsystem consists of the following:

- Realtek 8111HN-CG Gigabit Ethernet Controller (10/100/1000 Mb/s)
- RJ-45 LAN connector with integrated status LEDs
- Intel® Dual Band Wireless-AC 3165 module

Additional features of the LAN subsystem include:

- CSMA/CD protocol engine
- Jumbo frame support 9K
- LAN connect interface between the SoC and the LAN controller
- Power management capabilities
  - ACPI technology support
  - LAN wake capabilities
- LAN subsystem software

For information about	Refer to
LAN software and drivers	http://downloadcenter.intel.com

### 1.10.1 Realtek\* 8111HN Gigabit Ethernet Controller

The Realtek 8111HN Gigabit Ethernet Controller supports the following features:

- 10/100/1000 BASE-T IEEE 802.3 compliant
- Energy Efficient Ethernet (EEE) IEEE802.3az support (Low Power Idle (LPI) mode)
- Dual interconnect between the Integrated LAN Controller and the Physical Layer (PHY):
  - PCI Express-based interface for active state operation (S0) state
  - SMBUS for host and management traffic (Sx low power state)
- Compliant to IEEE 802.3x flow control support
- 802.1p and 802.1q
- TCP, IP, and UDP checksum offload (for IPv4 and IPv6)
- Full device driver compatibility

For information about	Refer to	
Full LAN Hardware feature set	http://www.realtek.com.tw/	

# 1.10.2 LAN Subsystem Software

LAN software and drivers are available from Intel's World Wide Web site.

For information about	Refer to	
Obtaining LAN software and drivers	http://downloadcenter.intel.com	

### 1.10.3 RJ-45 LAN Connector with Integrated LEDs

Two LEDs are built into the RJ-45 LAN connector (shown in Figure 7).

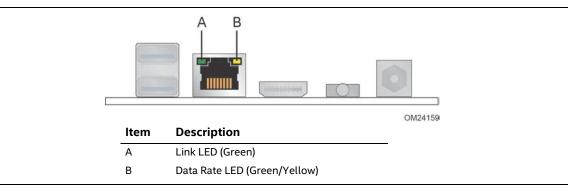


Figure 7. LAN Connector LED Locations

Table 5 describes the LED states when the board is powered up and the LAN subsystem is operating.

Table 5. LAN Connector LED States

LED	LED Color	LED State	Condition
		Off	LAN link is not established.
Link (A)	Green	On	LAN link is established.
		Blinking	LAN activity is occurring.
		Off	10 Mb/s data rate is selected.
Data Rate (B)	Green/Yellow	Green	100 Mb/s data rate is selected.
		Yellow	1000 Mb/s data rate is selected.

### 1.10.4 Wireless Network Module

The Intel Dual Band Wireless-AC 3165 module provides hi-speed wireless connectivity with the following capabilities:

- 2nd Gen 802.11ac, Dual Band, 1x1 Wi-Fi + Dual Mode Bluetooth 4.0
- Maximum Transfer speed up to 433Mbps
- Supports Intel® Wireless Display (WiDi)
- Supports Intel® Smart Connect Technology
- Pre-installed in M.2 2230 slot

For information about	Refer to
Obtaining WLAN software and drivers	http://downloadcenter.intel.com
Full Specifications	http://intel.com/wireless

# 1.11 Hardware Management Subsystem

The hardware management features enable the board to be compatible with the Wired for Management (WfM) specification. The board has several hardware management features, including thermal and voltage monitoring.

For information about	Refer to
Wired for Management (WfM) Specification	www.intel.com/design/archives/wfm/

### 1.11.1 Hardware Monitoring

The hardware monitoring and fan control subsystem is based on an ITE IT8607D embedded controller, which supports the following:

- · Processor and system ambient temperature monitoring
- Chassis fan speed monitoring
- Voltage monitoring of +5 V, +3.3 V, Memory Vcc (SDRAM)
- SMBus interface

### 1.11.2 Fan Monitoring

Fan monitoring can be implemented using third-party software.

### 1.11.3 Thermal Solution

Figure 8 shows the location of the thermal solution and processor fan header.

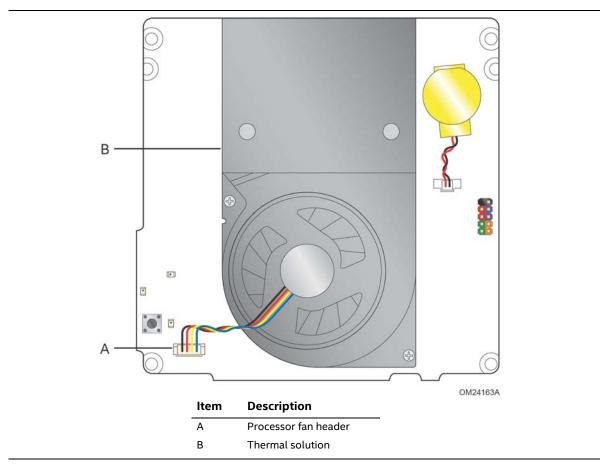


Figure 8. Thermal Solution and Fan Header

# 1.12 Power Management

Power management is implemented at several levels, including:

- Software support through Advanced Configuration and Power Interface (ACPI)
- Hardware support:
  - Power Input
  - Instantly Available PC technology
  - LAN wake capabilities
  - Wake from USB
  - WAKE# signal wake-up support
  - Wake from S5
  - Wake from CIR
  - +5 V Standby Power Indicator LED

### 1.12.1 ACPI

ACPI gives the operating system direct control over the power management and Plug and Play functions of a computer. The use of ACPI with this board requires an operating system that provides full ACPI support. ACPI features include:

- Plug and Play (including bus and device enumeration)
- Power management control of individual devices, add-in boards (some add-in boards may require an ACPI-aware driver), video displays, and disk drives
- Methods for achieving less than 15-watt system operation in the power-on/standby sleeping state
- A Soft-off feature that enables the operating system to power-off the computer
- Support for multiple wake-up events (see Table 8 on page 35)
- Support for a front panel power and sleep mode switch

Table 6 lists the system states based on how long the power switch is pressed, depending on how ACPI is configured with an ACPI-aware operating system.

Table 6. Effects of Pressing the Power Switch

If the system is in this state	and the power switch is pressed for	the system enters this state
Off	Less than four seconds	Power-on
(ACPI G2/G5 – Soft off)		(ACPI G0 – working state)
On	Less than four seconds	Soft-off/Standby
(ACPI G0 – working state)		(ACPI G1 – sleeping state) Note
On	More than six seconds	Fail safe power-off
(ACPI G0 – working state)		(ACPI G2/G5 – Soft off)
Sleep	Less than four seconds	Wake-up
(ACPI G1 – sleeping state)		(ACPI G0 – working state)
Sleep	More than six seconds	Power-off
(ACPI G1 – sleeping state)		(ACPI G2/G5 – Soft off)

Note: Depending on power management settings in the operating system.

### 1.12.1.1 System States and Power States

Under ACPI, the operating system directs all system and device power state transitions. The operating system puts devices in and out of low-power states based on user preferences and knowledge of how devices are being used by applications. Devices that are not being used can be turned off. The operating system uses information from applications and user settings to put the system as a whole into a low-power state.

Table 7 lists the power states supported by the board along with the associated system power targets. See the ACPI specification for a complete description of the various system and power states.

Table 7. Power States and Targeted System Power

Global States	Sleeping States	Processor States	Device States	Targeted System Power (Note 1)
G0 – working state	S0 – working	C0 – working	D0 – working state.	Full power
G1 – sleeping state	S3 – Suspend to RAM. Context saved to RAM.	No power	D3 – no power except for wake-up logic.	Power < 5 W (Note 2)
G1 – sleeping state	S4 – Suspend to disk. Context saved to disk.	No power	D3 – no power except for wake-up logic.	Power < 5 W (Note 2)
G2/S5	S5 – Soft off. Context not saved. Cold boot is required.	No power	D3 – no power except for wake-up logic.	Power < 5 W (Note 2)
G3 – mechanical off AC power is disconnected from the computer.	No power to the system.	No power	D3 – no power for wake-up logic, except when provided by battery or external source.	No power to the system. Service can be performed safely.

### Notes:

<sup>1.</sup> Total system power is dependent on the system configuration, including add-in boards and peripherals powered by the system chassis' power supply.

<sup>2.</sup> Dependent on the standby power consumption of wake-up devices used in the system.

#### 1.12.1.2 Wake-up Devices and Events

Table 8 lists the devices or specific events that can wake the computer from specific states.

Table 8. Wake-up Devices and Events

Devices/events that wake up the system	from this sleep state	Comments
Power switch	S3, S4, S5	
RTC alarm	S3, S4, S5 <sup>(Note 1)</sup>	Monitor to remain in sleep state
LAN	S3, S4, S5 <sup>(Notes 1, 2)</sup>	"S5 WOL after G3" must be supported; monitor to remain in sleep state
USB	S3, S4, S5 (Note 3, 4)	Wake S4, S5 controlled by BIOS option
PCIe via WAKE#	S3, S4, S5 <sup>(Note 1)</sup>	Via WAKE; monitor to remain in sleep state
Consumer IR	S3, S4, S5 (Notes 3, 4)	
Bluetooth	N/A	Wake from Bluetooth is not supported

#### Notes:

- 1. Monitor will remain in "sleep" state
- 2. "S5 WoL after G3" supported w/Deep Sleep disabled
- 3. Wake from S4 and S5 only supported w/Deep Sleep disabled
- 4. Wake from device/event not supported immediately upon return from AC loss



#### **NOTE**

The use of these wake-up events from an ACPI state requires an operating system that provides full ACPI support. In addition, software, drivers, and peripherals must fully support ACPI wake events.

# 1.12.2 Hardware Support

The board provides several power management hardware features, including:

- Wake from Power Button signal
- Instantly Available PC technology
- LAN wake capabilities
- Wake from USB
- WAKE# signal wake-up support
- Wake from S5
- Wake from CIR
- +5 V Standby Power Indicator LED



#### **NOTE**

The use of Wake from USB from an ACPI state requires an operating system that provides full ACPI support.

#### **1.12.2.1** Power Input

When resuming from an AC power failure, the computer may return to the power state it was in before power was interrupted (on or off). The computer's response can be set using the Last Power State feature in the BIOS Setup program's Boot menu.

#### 1.12.2.2 Instantly Available PC Technology

Instantly Available PC technology enables the board to enter the ACPI S3 (Suspend-to-RAM) sleep-state. While in the S3 sleep-state, the computer will appear to be off (the power supply is off, and the front panel LED is amber if dual colored, or off if single colored.) When signaled by a wake-up device or event, the system quickly returns to its last known wake state. Table 8 on page 35 lists the devices and events that can wake the computer from the S3 state.

The use of Instantly Available PC technology requires operating system support and drivers for any installed PCI Express add-in card.

#### 1.12.2.3 LAN Wake Capabilities

LAN wake capabilities enable remote wake-up of the computer through a network. The LAN subsystem monitors network traffic at the Media Independent Interface. Upon detecting a Magic Packet\* frame, the LAN subsystem asserts a wake-up signal that powers up the computer.

#### 1.12.2.4 Wake from USB

USB bus activity wakes the computer from an ACPI S3, S4, and S5 states.



#### **NOTE**

Wake from USB requires the use of a USB peripheral that supports Wake from USB.

#### 1.12.2.5 WAKE# Signal Wake-up Support

When the WAKE# signal on the PCI Express bus is asserted, the computer wakes from an ACPI S3, S4, or S5 state.

#### 1.12.2.6 Wake from S5

When the RTC Date and Time is set in the BIOS, the computer will automatically wake from an ACPI S5 state.

#### 1.12.2.7 Wake from Consumer IR

CIR activity wakes the computer from an ACPI S3, S4, or S5 state.

#### +5 V Standby Power Indicator LED 1.12.2.8

The standby power indicator LED shows that power is still present even when the computer appears to be off. Figure 9 shows the location of the standby power LED.



# **L** CAUTION

If AC power has been switched off and the standby power indicator is still lit, disconnect the power cord before installing or removing any devices connected to the board. Failure to do so could damage the board and any attached devices.

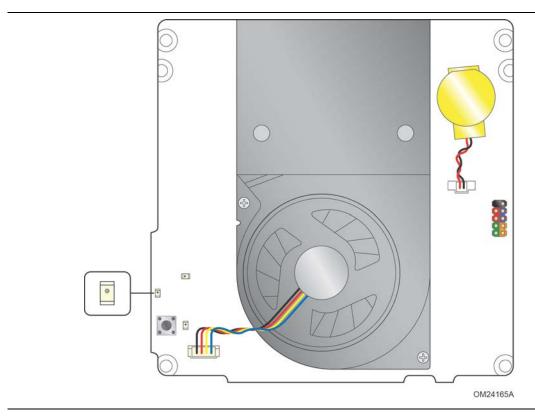


Figure 9. Location of the Standby Power LED

#### **Technical Reference** 2

#### **Memory Resources** 2.1

#### **Addressable Memory** 2.1.1

The board utilizes up to 8 GB of addressable system memory. Typically the address space that is allocated for PCI Conventional bus add-in cards, PCI Express configuration space, BIOS (SPI Flash device), and chipset overhead resides above the top of DRAM (total system memory). On a system that has 8 GB of system memory installed, it is not possible to use all of the installed memory due to system address space being allocated for other system critical functions. These functions include the following:

- BIOS/SPI Flash device (64 Mbit)
- Local APIC (19 MB)
- Direct Media Interface (40 MB)
- PCI Express configuration space (256 MB)
- SoC base address registers PCI Express ports (up to 256 MB)
- Memory-mapped I/O (I/O fabric) that is dynamically allocated for PCI Express add-in cards (256 MB)

The board provides the capability to reclaim the physical memory overlapped by the memory mapped I/O logical address space. The board remaps physical memory from the top of usable DRAM boundary to the 4 GB boundary to an equivalent sized logical address range located just above the 4 GB boundary. All installed system memory can be used when there is no overlap of system addresses.

#### 2.2 **Connectors and Headers**



# **L** CAUTION

Only the following connectors and headers have overcurrent protection: back panel and front panel USB.

This section describes the board's connectors and headers. The connectors and headers can be divided into these groups:

- Front panel I/O connector
- Back panel I/O connectors

#### 2.2.1 Front Panel Connectors

Figure 10 shows the location of the front panel connectors for the board.

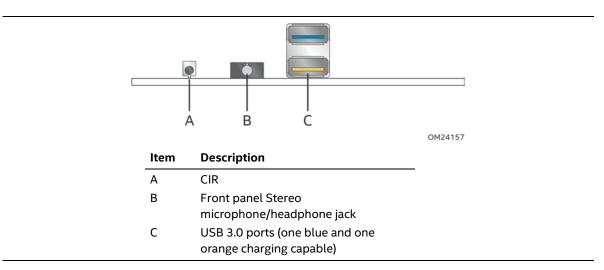


Figure 10. Front Panel Connectors

## 2.2.2 Back Panel Connectors

Figure 11 shows the location of the back panel connectors for the board.

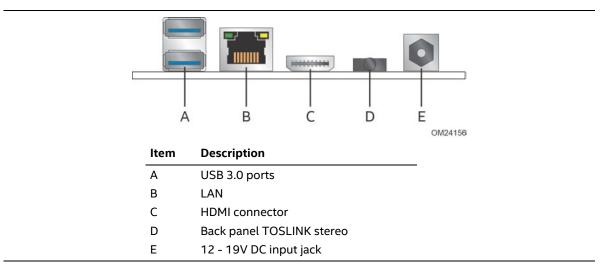


Figure 11. Back Panel Connectors

# 2.2.3 Headers and Connectors (Top)

Figure 12 shows the location of the headers and connectors on the top-side of the board.

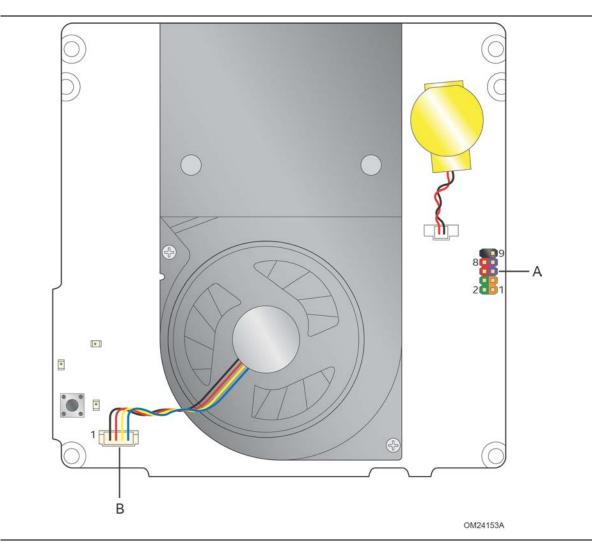


Figure 12. Headers and Connectors (Top)

Table 9 lists the headers and connectors identified in Figure 12.

Table 9. Headers and Connectors Shown in Figure 12

Item from Figure 12	Description	
A	Front panel header	
В	Processor fan header	

# 2.2.4 Connectors and Headers (Bottom)

Figure 13 shows the locations of the connectors and headers on the bottom-side of the board.

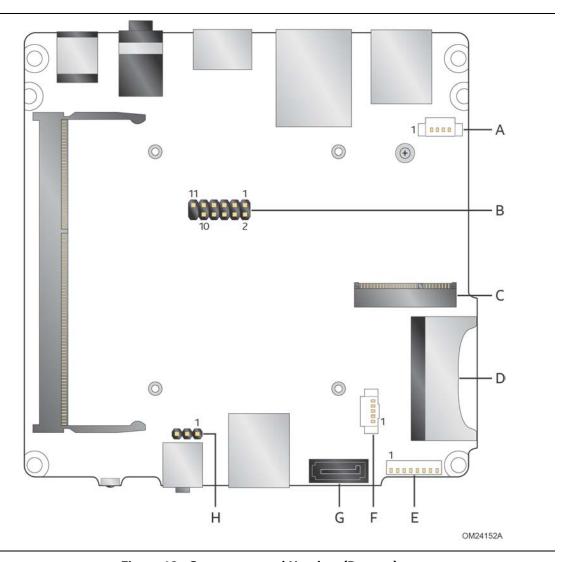


Figure 13. Connectors and Headers (Bottom)

Table 10 lists the connectors and headers identified in Figure 13.

Table 10. Connectors and Headers Shown in Figure 13

Item from Figure 13	Description
A	Auxiliary power connector (1.25 mm pitch)
В	VGA connector
С	M.2 2230 Module connector
D	SDXC slot
Е	Front panel dual-port USB 2.0 header (1.25 mm pitch)
F	SATA power connector (1.25 mm pitch)
G	SATA 6.0 Gb/s connector
Н	BIOS security jumper

# 2.2.4.1 Signal Tables for the Connectors and Headers

Table 11. VGA Header

Pin	Signal Name	Pin	Signal Name
1	CLK	2	DATA
3	VCC	4	VSYNC
5	HSYNC	6	GND
7	RED	8	GND
9	GREEN	10	GND
11	BLUE	12	KEY

Table 12. SATA Power Header (1.25 mm Pitch)

Pin	Signal Name
1	5 V
2	5 V
3	3.3 V
4	GND
5	GND



#### NOTE

Connector is Molex\* part number 53398-0571, 1.25 mm pitch PicoBlade\* header, surface mount, vertical, lead-free, 5 circuits.

Table 13. Dual-Port Internal USB 2.0 Header (1.25 mm Pitch)

Pin	Signal Name	Pin	Signal Name
1	+5 V DC	2	Data (negative)
3	Data (positive)	4	Ground
5	Ground	6	Data (positive)
7	Data (negative)	8	+5 V DC



#### NOTE

Connector is Molex part number 53398-0571, 1.25 mm pitch PicoBlade header, surface mount, vertical, lead-free, 8 circuits.

Table 14. M.2 2230 Module (Mechanical Key E) Connector

74         3.3V         75         GND           72         3.3V         73         RESERVED           70         RESERVED         71         RESERVED           68         RESERVED         69         GND           66         RESERVED         67         RESERVED           64         RESERVED         65         RESERVED           62         ALERT# (I)(0/3.3)         63         GND           60         12C CLX (O)(0/3.3)         59         RESERVED           58         12C DATA (I/O)(0/3.3)         59         RESERVED           54         W_DISABLE# (O)(0/3.3V)         57         GND           54         W_DISABLE# (O)(0/3.3V)         53         CLKREQO# (I/O)(0/3.3V)           50         SUSCLK(32kHz) (O)(0/3.3V)         51         GND           48         RESERVED         49         REFCLKNO           46         RESERVED         47         REFCLKPO           44         RESERVED         45         GND           42         C-Link CLK (I/O)         43         PERNO           44         RESERVED         37         PETNO           34         RESERVED         35         PETPO	Pin	Signal Name	Pin	Signal Name
RESERVED	74	3.3V	75	GND
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64 RESERVED 65 RESERVED 62 ALERT# (I)(O/3.3) 63 GND 60 I2C CLK (O)(O/3.3) 61 RESERVED 58 I2C DATA (I/O)(O/3.3) 59 RESERVED 56 W_DISABLE# (O)(O/3.3V) 57 GND 57 GND 58 PERSTO# (O)(O/3.3V) 59 PEWAKEO# (I/O)(O/3.3V) 59 PERSTO# (O)(O/3.3V) 51 GND 50 SUSCLK(32kHz) (O)(O/3.3V) 51 GND 51 GND 52 PERSTO# (O)(O/3.3V) 51 GND 53 CLKREQO# (I/O)(O/3.3V) 51 GND 54 RESERVED 49 REFCLKNO 55 RESERVED 47 REFCLKNO 66 RESERVED 45 GND 66 RESERVED 45 GND 67 GND 68 GND 69 GND 69 GND 60 C-Link CLK (I/O) 41 PERPO 60 GND 61 GND 63 GND 64 RESERVED 37 PETPO 63 GND 64 RESERVED 37 PETPO 65 GND 66 RESERVED 37 PETPO 66 Connector Key 31 Connector Key 29 Connector Key 29 Connector Key 29 Connector Key 29 Connector Key 20 Connector Key 20 RESERVED 21 RESERVED 22 RESERVED 21 RESERVED 21 RESERVED 22 RESERVED 21 RESERVED 21 RESERVED 22 RESERVED 22 RESERVED 23 RESERVED 24 RESERVED 25 RESERVED 25 RESERVED 26 RESERVED 27 RESERVED 27 RESERVED 27 RESERVED 27 RESERVED 27 RESERVED 27 RESERVED 28 RESERVED 29 RESERVED 20 RESERVED 29 RESERVED 20 RESERVED 29 RESERVED 20 RES	68	RESERVED	69	GND
62 ALERT# (I)(0/3.3) 63 GND 60 I2C CLK (O)(0/3.3) 61 RESERVED 58 I2C DATA (I/O)(0/3.3) 59 RESERVED 56 W_DISABLE1# (O)(0/3.3V) 57 GND 57 GND 58 SUSCLK(32kH2 (O)(0/3.3V) 55 PEWAKEO# (I/O)(0/3.3V) 59 PERSTO# (O)(0/3.3V) 55 PEWAKEO# (I/O)(0/3.3V) 50 SUSCLK(32kH2) (O)(0/3.3V) 51 GND 48 RESERVED 49 REFCLKNO 46 RESERVED 47 REFCLKNO 46 RESERVED 45 GND 47 REFCLKPO 48 RESERVED 45 GND 49 REFOLK (I/O) 43 PERD 40 C-Link CLK (I/O) 41 PERD 38 C-Link RESET (I) (0/3.3V) 39 GND 36 RESERVED 37 PETD 34 RESERVED 35 PETD 35 PETD 36 RESERVED 36 GND 37 RESERVED 37 PETD 38 CONNECTOR KEY 29 CONNECTOR KEY 28 CONNECTOR KEY 29 CONNECTOR KEY 28 CONNECTOR KEY 27 CONNECTOR KEY 29 CONNECTOR KEY 20 RESERVED 23 RESERVED 30 RESERVED 23 RESERVED 31 RESERVED 23 RESERVED 32 RESERVED 21 RESERVED 33 RESERVED 21 RESERVED 34 RESERVED 21 RESERVED 35 RESERVED 21 RESERVED 36 RESERVED 21 RESERVED 37 RESERVED 21 RESERVED 38 CONNECTOR KEY 25 CONNECTOR KEY 29 CONNECTOR KEY 20 RESERVED 21 RESERVED 21 RESERVED 21 RESERVED 22 RESERVED 21 RESERVED 33 RESERVED 31 RESERVED 34 RESERVED 31 RESERVED 35 RESERVED 31 RESERVED 36 RESERVED 31 RESERVED 37 RESERVED 31 RESERVED 38 RESERVED 31 RESERVED 39 RESERVED 31 RESERVED 30 RESERVED 31 RESERVED 31 RESERVED 32 RESERVED 32 RESERVED 33 RESERVED 34 RESERVED 31 RESERVED 35 RESERVED 31 RESERVED 36 RESERVED 31 RESERVED 37 RESERVED 31 RESERVED 38 RESERVED 31 RESERVED 39 RESERVED 31 RESERVED 30 RESERVED 31 RESERVED 30 RESERVED 31 RESERVED 30 RESERVED 31 RESERVED 31 RESERVED 31 RESERVED 32 RESERVED 31 RESERVED 33 RESERVED 31 RESERVED 34 RESERVED 31 RESERVED 35 RESERVED 31 RESERVED 36 RESERVED 31 RESERVED 37 RESERVED 31 RESERVED 38 RESERVED 31 RESERVED 39 RESERVED 31 RESERVED 30 RESERVED 31 RESERVED 30 RESERVED 32 RESERVED 31 RESERVED 33 RESERVED 32 RESERVED 33 RESERVED 33 RESERVED 34 RESERVED 34 RESERVED 35 RESERVED	66	RESERVED	67	RESERVED
60	64	RESERVED	65	RESERVED
58         I2C DATA (I/O)(O/O.3.3)         59         RESERVED           56         W_DISABLE1# (O)(O/O.3.3V)         57         GND           54         W_DISABLE2# (O)(O/O.3.3V)         55         PEWAKE0# (I/O)(O/O.3.3V)           52         PERSTO# (O)(O/O.3.3V)         53         CLKREQO# (I/O)(O/O.3.3V)           50         SUSCLK(O.2KHZ) (O)(O/O.3.3V)         51         GND           48         RESERVED         49         REFCLKNO           46         RESERVED         47         REFCLKPO           44         RESERVED         45         GND           42         C-Link CLK (I/O)         43         PERDO           40         C-Link RESET (I) (O/O.3.3V)         39         GND           38         C-Link RESET (I) (O/O.3.3V)         39         GND           34         RESERVED         35         PETPO           34         RESERVED         33         GND           30         Connector Key         29         Connector Key           28         Connector Key         27         Connector Key           24         Connector Key         27         Connector Key           22         RESERVED         21         RESERVED	62	ALERT# (I)(0/3.3)	63	GND
56         W_DISABLE1# (O)(O/3.3V)         57         GND           54         W_DISABLE2# (O)(O/3.3V)         55         PEWAKE0# (I/O)(O/3.3V)           52         PERST0# (O)(O/3.3V)         53         CLKREQ0# (I/O)(O/3.3V)           50         SUSCLK(32kHz) (O)(O/3.3V)         51         GND           48         RESERVED         49         REFCLKNO           46         RESERVED         47         REFCLKPO           44         RESERVED         45         GND           42         C-Link CLK (I/O)         43         PERNO           40         C-Link DATA (I/O)         41         PERPO           38         C-Link RESET (I) (O/3.3V)         39         GND           36         RESERVED         37         PETnO           34         RESERVED         35         PETpO           32         RESERVED         33         GND           30         Connector Key         29         Connector Key           28         Connector Key         29         Connector Key           24         Connector Key         25         Connector Key           22         RESERVED         21         RESERVED           16         RES	60	I2C CLK (O)(0/3.3)	61	RESERVED
54         W_DISABLE2# (O)(O/3.3V)         55         PEWAKEO# (I/O)(O/3.3V)           52         PERSTO# (O)(O/3.3V)         53         CLKREQO# (I/O)(O/3.3V)           50         SUSCLK(32kHz) (O)(O/3.3V)         51         GND           48         RESERVED         49         REFCLKNO           46         RESERVED         47         REFCLKPO           44         RESERVED         45         GND           42         C-Link CLK (I/O)         43         PERNO           40         C-Link DATA (I/O)         41         PERPO           38         C-Link RESET (I) (O/3.3V)         39         GND           36         RESERVED         35         PETpO           34         RESERVED         35         PETpO           32         RESERVED         33         GND           30         Connector Key         29         Connector Key           28         Connector Key         29         Connector Key           24         Connector Key         25         Connector Key           22         RESERVED         21         RESERVED           18         GND         19         RESERVED           16         RESERVED	58	I2C DATA (I/O)(0/3.3)	59	RESERVED
52         PERSTO# (O)(O/3.3V)         53         CLKREQO# (I/O)(O/3.3V)           50         SUSCLK(32kHz) (O)(O/3.3V)         51         GND           48         RESERVED         49         REFCLKNO           46         RESERVED         47         REFCLKPO           44         RESERVED         45         GND           42         C-Link CLK (I/O)         43         PERNO           40         C-Link DATA (I/O)         41         PERPO           38         C-Link RESET (I) (O/3.3V)         39         GND           36         RESERVED         37         PETnO           34         RESERVED         35         PETpO           32         RESERVED         33         GND           30         Connector Key         29         Connector Key           28         Connector Key         29         Connector Key           26         Connector Key         27         Connector Key           22         RESERVED         23         RESERVED           20         RESERVED         21         RESERVED           16         RESERVED         17         RESERVED           10         RESERVED         13	56	W_DISABLE1# (O)(0/3.3V)	57	GND
50         SUSCLK(32kHz) (O)(0/3.3V)         51         GND           48         RESERVED         49         REFCLKNO           46         RESERVED         47         REFCLKPO           44         RESERVED         45         GND           42         C-Link CLK (I/O)         43         PERnO           40         C-Link DATA (I/O)         41         PERpO           38         C-Link RESET (I) (0/3.3V)         39         GND           36         RESERVED         37         PETnO           34         RESERVED         35         PETpO           32         RESERVED         33         GND           30         Connector Key         29         Connector Key           28         Connector Key         29         Connector Key           26         Connector Key         27         Connector Key           24         Connector Key         25         Connector Key           22         RESERVED         23         RESERVED           18         GND         19         RESERVED           16         RESERVED         15         RESERVED           10         RESERVED         11         RESERVED	54	W_DISABLE2# (O)(0/3.3V)	55	PEWAKE0# (I/O)(0/3.3V)
48         RESERVED         49         REFCLKNO           46         RESERVED         47         REFCLKPO           44         RESERVED         45         GND           42         C-Link CLK (I/O)         43         PERnO           40         C-Link DATA (I/O)         41         PERpO           38         C-Link RESET (I) (0/3.3V)         39         GND           36         RESERVED         37         PETnO           34         RESERVED         35         PETpO           32         RESERVED         33         GND           30         Connector Key         29         Connector Key           28         Connector Key         29         Connector Key           26         Connector Key         27         Connector Key           24         Connector Key         25         Connector Key           22         RESERVED         21         RESERVED           18         GND         19         RESERVED           16         RESERVED         15         RESERVED           10         RESERVED         13         RESERVED           10         RESERVED         11         RESERVED	52	PERST0# (O)(0/3.3V)	53	CLKREQ0# (I/O)(0/3.3V)
46         RESERVED         47         REFCLKPO           44         RESERVED         45         GND           42         C-Link CLK (I/O)         43         PERNO           40         C-Link DATA (I/O)         41         PERpO           38         C-Link RESET (I) (0/3.3V)         39         GND           36         RESERVED         37         PETnO           34         RESERVED         35         PETpO           32         RESERVED         33         GND           30         Connector Key         29         Connector Key           28         Connector Key         29         Connector Key           26         Connector Key         27         Connector Key           24         Connector Key         25         Connector Key           22         RESERVED         23         RESERVED           18         GND         19         RESERVED           16         RESERVED         17         RESERVED           14         RESERVED         15         RESERVED           10         RESERVED         11         RESERVED           10         RESERVED         7         GND	50	SUSCLK(32kHz) (O)(0/3.3V)	51	GND
44       RESERVED       45       GND         42       C-Link CLK (I/O)       43       PERNO         40       C-Link DATA (I/O)       41       PERpO         38       C-Link RESET (I) (0/3.3V)       39       GND         36       RESERVED       37       PETnO         34       RESERVED       35       PETpO         32       RESERVED       33       GND         30       Connector Key       29       Connector Key         28       Connector Key       29       Connector Key         26       Connector Key       27       Connector Key         24       Connector Key       25       Connector Key         22       RESERVED       23       RESERVED         20       RESERVED       21       RESERVED         18       GND       19       RESERVED         16       RESERVED       17       RESERVED         14       RESERVED       15       RESERVED         10       RESERVED       11       RESERVED         8       RESERVED       7       GND         4       3.3V       5       USB_D-         2       3.3V	48	RESERVED	49	REFCLKNO
42       C-Link CLK (I/O)       43       PERNO         40       C-Link DATA (I/O)       41       PERPO         38       C-Link RESET (I) (O/3.3V)       39       GND         36       RESERVED       37       PETnO         34       RESERVED       35       PETpO         32       RESERVED       33       GND         30       Connector Key       21       Connector Key         28       Connector Key       29       Connector Key         26       Connector Key       27       Connector Key         24       Connector Key       25       Connector Key         22       RESERVED       23       RESERVED         20       RESERVED       21       RESERVED         16       RESERVED       17       RESERVED         14       RESERVED       15       RESERVED         12       RESERVED       13       RESERVED         10       RESERVED       11       RESERVED         8       RESERVED       7       GND         4       3.3V       5       USB_D-         2       3.3V       3       USB_D+	46	RESERVED	47	REFCLKP0
40	44	RESERVED	45	GND
38         C-Link RESET (I) (0/3.3V)         39         GND           36         RESERVED         37         PETnO           34         RESERVED         35         PETpO           32         RESERVED         33         GND           30         Connector Key         31         Connector Key           28         Connector Key         29         Connector Key           26         Connector Key         27         Connector Key           24         Connector Key         25         Connector Key           22         RESERVED         23         RESERVED           18         GND         19         RESERVED           16         RESERVED         17         RESERVED           14         RESERVED         15         RESERVED           10         RESERVED         13         RESERVED           10         RESERVED         9         RESERVED           6         RESERVED         7         GND           4         3.3V         5         USB_D-           2         3.3V         3         USB_D+	42	C-Link CLK (I/O)	43	PERn0
36       RESERVED       37       PETnO         34       RESERVED       35       PETpO         32       RESERVED       33       GND         30       Connector Key       31       Connector Key         28       Connector Key       29       Connector Key         26       Connector Key       27       Connector Key         24       Connector Key       25       Connector Key         22       RESERVED       23       RESERVED         18       GND       19       RESERVED         16       RESERVED       17       RESERVED         14       RESERVED       15       RESERVED         12       RESERVED       13       RESERVED         10       RESERVED       11       RESERVED         8       RESERVED       9       RESERVED         6       RESERVED       7       GND         4       3.3V       5       USB_D-         2       3.3V       3       USB_D+	40	C-Link DATA (I/O)	41	PERp0
34       RESERVED       35       PETp0         32       RESERVED       33       GND         30       Connector Key       31       Connector Key         28       Connector Key       29       Connector Key         26       Connector Key       27       Connector Key         24       Connector Key       25       Connector Key         22       RESERVED       23       RESERVED         18       GND       19       RESERVED         16       RESERVED       17       RESERVED         14       RESERVED       15       RESERVED         12       RESERVED       13       RESERVED         10       RESERVED       11       RESERVED         8       RESERVED       9       RESERVED         6       RESERVED       7       GND         4       3.3V       5       USB_D-         2       3.3V       3       USB_D+	38	C-Link RESET (I) (0/3.3V)	39	GND
32       RESERVED       33       GND         30       Connector Key       31       Connector Key         28       Connector Key       29       Connector Key         26       Connector Key       27       Connector Key         24       Connector Key       25       Connector Key         22       RESERVED       23       RESERVED         20       RESERVED       21       RESERVED         18       GND       19       RESERVED         16       RESERVED       17       RESERVED         14       RESERVED       15       RESERVED         12       RESERVED       13       RESERVED         10       RESERVED       11       RESERVED         8       RESERVED       9       RESERVED         6       RESERVED       7       GND         4       3.3V       5       USB_D-         2       3.3V       3       USB_D+	36	RESERVED	37	PETn0
30         Connector Key         31         Connector Key           28         Connector Key         29         Connector Key           26         Connector Key         27         Connector Key           24         Connector Key         25         Connector Key           22         RESERVED         23         RESERVED           20         RESERVED         21         RESERVED           18         GND         19         RESERVED           16         RESERVED         17         RESERVED           14         RESERVED         15         RESERVED           12         RESERVED         13         RESERVED           10         RESERVED         11         RESERVED           8         RESERVED         9         RESERVED           6         RESERVED         7         GND           4         3.3V         5         USB_D-           2         3.3V         3         USB_D+	34	RESERVED	35	PETp0
28         Connector Key         29         Connector Key           26         Connector Key         27         Connector Key           24         Connector Key         25         Connector Key           22         RESERVED         23         RESERVED           20         RESERVED         21         RESERVED           18         GND         19         RESERVED           16         RESERVED         17         RESERVED           14         RESERVED         15         RESERVED           12         RESERVED         13         RESERVED           10         RESERVED         11         RESERVED           8         RESERVED         9         RESERVED           6         RESERVED         7         GND           4         3.3V         5         USB_D-           2         3.3V         3         USB_D+	32	RESERVED	33	GND
26         Connector Key         27         Connector Key           24         Connector Key         25         Connector Key           22         RESERVED         23         RESERVED           20         RESERVED         21         RESERVED           18         GND         19         RESERVED           16         RESERVED         17         RESERVED           14         RESERVED         15         RESERVED           12         RESERVED         13         RESERVED           10         RESERVED         11         RESERVED           8         RESERVED         9         RESERVED           6         RESERVED         7         GND           4         3.3V         5         USB_D-           2         3.3V         3         USB_D+	30	Connector Key	31	Connector Key
24       Connector Key       25       Connector Key         22       RESERVED       23       RESERVED         20       RESERVED       21       RESERVED         18       GND       19       RESERVED         16       RESERVED       17       RESERVED         14       RESERVED       15       RESERVED         12       RESERVED       13       RESERVED         10       RESERVED       11       RESERVED         8       RESERVED       9       RESERVED         6       RESERVED       7       GND         4       3.3V       5       USB_D-         2       3.3V       3       USB_D+	28	Connector Key	29	Connector Key
22       RESERVED       23       RESERVED         20       RESERVED       21       RESERVED         18       GND       19       RESERVED         16       RESERVED       17       RESERVED         14       RESERVED       15       RESERVED         12       RESERVED       13       RESERVED         10       RESERVED       11       RESERVED         8       RESERVED       9       RESERVED         6       RESERVED       7       GND         4       3.3V       5       USB_D-         2       3.3V       3       USB_D+	26	Connector Key	27	Connector Key
20       RESERVED       21       RESERVED         18       GND       19       RESERVED         16       RESERVED       17       RESERVED         14       RESERVED       15       RESERVED         12       RESERVED       13       RESERVED         10       RESERVED       11       RESERVED         8       RESERVED       9       RESERVED         6       RESERVED       7       GND         4       3.3V       5       USB_D-         2       3.3V       3       USB_D+	24	Connector Key	25	Connector Key
18       GND       19       RESERVED         16       RESERVED       17       RESERVED         14       RESERVED       15       RESERVED         12       RESERVED       13       RESERVED         10       RESERVED       11       RESERVED         8       RESERVED       9       RESERVED         6       RESERVED       7       GND         4       3.3V       5       USB_D-         2       3.3V       3       USB_D+	22	RESERVED	23	RESERVED
16       RESERVED       17       RESERVED         14       RESERVED       15       RESERVED         12       RESERVED       13       RESERVED         10       RESERVED       11       RESERVED         8       RESERVED       9       RESERVED         6       RESERVED       7       GND         4       3.3V       5       USB_D-         2       3.3V       3       USB_D+	20	RESERVED	21	RESERVED
14       RESERVED       15       RESERVED         12       RESERVED       13       RESERVED         10       RESERVED       11       RESERVED         8       RESERVED       9       RESERVED         6       RESERVED       7       GND         4       3.3V       5       USB_D-         2       3.3V       3       USB_D+	18	GND	19	RESERVED
12       RESERVED       13       RESERVED         10       RESERVED       11       RESERVED         8       RESERVED       9       RESERVED         6       RESERVED       7       GND         4       3.3V       5       USB_D-         2       3.3V       3       USB_D+	16	RESERVED	17	RESERVED
10       RESERVED       11       RESERVED         8       RESERVED       9       RESERVED         6       RESERVED       7       GND         4       3.3V       5       USB_D-         2       3.3V       3       USB_D+	14	RESERVED	15	RESERVED
8         RESERVED         9         RESERVED           6         RESERVED         7         GND           4         3.3V         5         USB_D-           2         3.3V         3         USB_D+	12	RESERVED	13	RESERVED
6 RESERVED 7 GND 4 3.3V 5 USB_D- 2 3.3V 3 USB_D+	10	RESERVED	11	RESERVED
4 3.3V 5 USB_D- 2 3.3V 3 USB_D+	8	RESERVED	9	RESERVED
2 3.3V 3 USB_D+	6	RESERVED	7	GND
	4	3.3V	5	USB_D-
1 GND	2	3.3V	3	USB_D+
			1	GND

#### 2.2.4.2 Add-in Card Connector

The board supports a M.2 2230 (key type E) module.

• Supports M.2 communication module

#### 2.2.4.3 SDXC Card Reader

The board has a standard Secure Digital (SD) card reader that supports the Secure Digital eXtended Capacity (SDXC) format, 3.01 specification with UHS-I support. SD Card sizes supported from 8GB to 128GB.

**Table 15. SDXC Card Reader Connector** 

Pin	Signal Name	Descriptive Name
1	CD	Card Detection
2	DATA2	Serial Data 2
3	DATA3	Serial Data 3
4	CMD	Command
5	VSS1	Ground
6	VDD	Power (3.3 V)
7	CLK	Serial Clock
8	VSS2	Ground
9	DATAO	Serial Data 0
10	DATA1	Serial Data 1
11	WP	Write Protect



#### NOTE

The SD card reader is not supported in Microsoft\* Windows\* 7

#### 2.2.4.4 Power Supply Connector

The board has the following power supply connector:

• External Power Supply – the board can be powered through a 12-19 V DC connector on the back panel. The back panel DC connector is compatible with a 5.5 mm/OD (outer diameter) and 2.5 mm/ID (inner diameter) plug, where the inner contact is +12 (±10%) V DC and the shell is GND. The maximum current rating is 3 A.



#### NOTE

External power voltage, 12-19 V DC, is dependent on the type of power brick used.

**Table 16. Auxiliary Power Connector** 

Pin	Signal Name	Descriptive Name
1	+5VSB	5V
2	PCH_GPIO24	Power draw sensor
3	GND	Ground
4	+VIN	12V – 19V DC input



## NOTE

The Auxiliary Power Connector is a limited voltage source (output) for 5V Standby and the voltage supplied to the board (typically 19V DC) for use by expansion peripherals. The Auxiliary Power Connector is limited to 1.5A max (fused).



#### **NOTE**

JTE (JOINT TECH): A1250WV-S-04P A-Series (Wire to Board) Vertical SMT Connector, 1.25mm pitch, 1A rating. Mates with JTE A1250 Series Housing.

For information about	Refer to
Power supply considerations	Section 2.5.1, page 55

#### 2.2.4.5 Front Panel Header (2.0 mm Pitch)

This section describes the functions of the front panel header. Table 17 lists the signal names of the front panel header. Figure 14 is a connection diagram for the front panel header.

Table 17. Front Panel Header (2.0	) mm	Pitch)
-----------------------------------	------	--------

Pin	Signal Name	Description	Pin	Signal Name	Description
1	HDD_POWER_LED	Pull-up resistor (750 Ω) to +5V	2	POWER_LED_MAIN	[Out] Front panel LED (main color)
3	HDD_LED#	[Out] Hard disk activity LED	4	POWER_LED_ALT	[Out] Front panel LED (alt color)
5	GROUND	Ground	6	POWER_SWITCH#	[In] Power switch
7	RESET_SWITCH#	[In] Reset switch	8	GROUND	Ground
9	+5V_DC	Power (2A)	10	Key	No pin

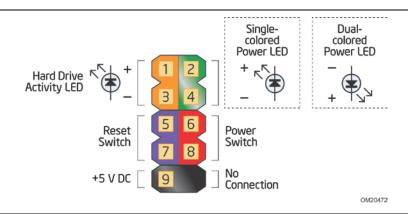


Figure 14. Connection Diagram for Front Panel Header (2.0 mm Pitch)

#### 2.2.4.5.1 Hard Drive Activity LED Header

Pins 1 and 3 can be connected to an LED to provide a visual indicator that data is being read from or written to a hard drive. Proper LED function requires a SATA hard drive or optical drive connected to an onboard SATA connector.

#### 2.2.4.5.2 Reset Switch Header

Pins 5 and 7 can be connected to a momentary single pole, single throw (SPST) type switch that is normally open. When the switch is closed, the board resets and runs the POST.

#### 2.2.4.5.3 Power/Sleep LED Header

Pins 2 and 4 can be connected to a one- or two-color LED. Table 18 and Table 19 show the possible LED states.

Table 18. States for a One-Color Power LED

LED State	Description
Off	Power off
Blinking	Standby
Steady	Normal operation

Table 19. States for a Dual-Color Power LED

LED State	Description
Off	Power off
Secondary color blinking (amber)	Standby
Primary color steady (white)	Normal operation



#### NOTE

The LED behavior shown in Table 18 is default – other patterns may be set via BIOS setup.

#### 2.2.4.5.4 Power Switch Header

Pins 6 and 8 can be connected to a front panel momentary-contact power switch. The switch must pull the SW\_ON# pin to ground for at least 50 ms to signal the power supply to switch on or off. (The time requirement is due to internal debounce circuitry on the board.) At least two seconds must pass before the power supply will recognize another on/off signal.

#### 2.2.4.5.5 5V DC Power Header

Pin 6 can supply 2A of 5V DC (VCC) power. Any usage of power from this header should be considered when calculating the system's total power budget.

For information about	Refer to
Power supply considerations	Section 2.5.1, page 55

### 2.2.4.6 Consumer Infrared (CIR) Sensor

The Consumer Infrared (CIR) sensor on the front panel provides features that are designed to comply with Microsoft Consumer Infrared usage models.

The CIR feature is made up of the receiving sensor. The receiving sensor consists of a filtered translated infrared input compliant with Microsoft CIR specifications.

Customers are required to provide their own media center compatible remote or smart phone application for use with the Intel NUC. Figure 15 shows the location of the CIR sensor.

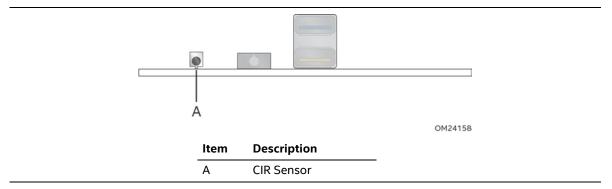


Figure 15. Location of the CIR Sensor

## 2.2.4.7 Internal USB 2.0 Dual-Port Header (1.25 mm Pitch)

Figure 16 is a connection diagram for the internal USB header.

Connector is Molex part number 53398-0571, 1.25 mm pitch PicoBlade header, surface mount, vertical, lead-free, 8 circuits.



#### NOTE

- The +5 V DC power on the USB header is fused.
- Use only an internal USB connector that conforms to the USB 2.0 specification for high-speed USB devices.

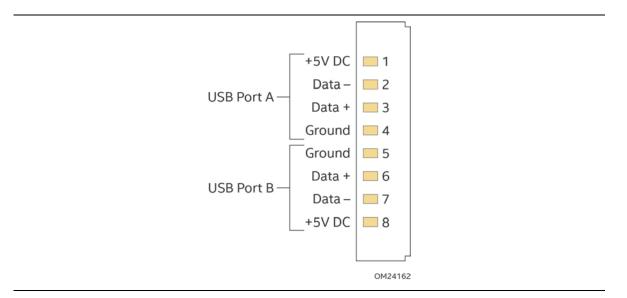


Figure 16. Connection Diagram for Internal USB 2.0 Dual-Port Header (1.25 mm Pitch)

#### **BIOS Security Jumper** 2.3



# **A** CAUTION

Do not move a jumper with the power on. Always turn off the power and unplug the power cord from the computer before changing a jumper setting. Otherwise, the board could be damaged.

Figure 17 shows the location of the BIOS security jumper. The 3-pin jumper determines the BIOS Security program's mode. Table 20 describes the BIOS security jumper settings for the three modes: normal, lockdown, and configuration.

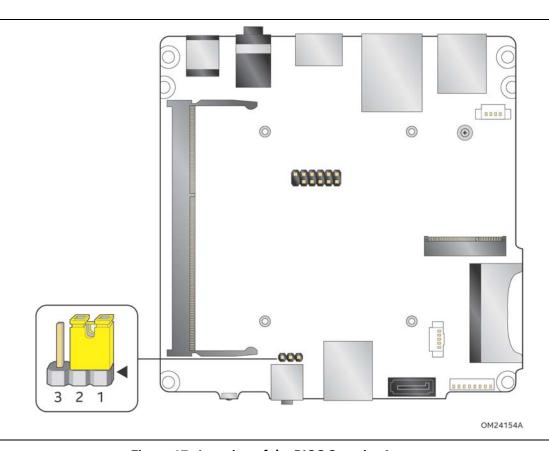


Figure 17. Location of the BIOS Security Jumper

Table 20 lists the settings for the jumper.

Table 20. BIOS Security Jumper Settings

Function/Mode	Jumper Setting	Configuration
Normal	1-2	The BIOS uses current configuration information and passwords for booting.
Lockdown	2-3	The BIOS uses current configuration information and passwords for booting, except:
		All POST Hotkeys are suppressed (prompts are not displayed and keys are not accepted. For example, F2 for Setup, F10 for the Boot Menu).
		Power Button Menu is not available (see Section 3.7.4 Power Button Menu).
		BIOS updates are not available except for automatic Recovery due to flash corruption.
Configuration	None	BIOS Recovery Update process if a matching *.bio file is found. Recovery Update can be cancelled by pressing the Esc key.
		If the Recovery Update was cancelled or a matching *.bio file was not found, a Config Menu will be displayed. The Config Menu consists of the following (followed by the Power Button Menu selections):
		[1] Suppress this menu until the BIOS Security Jumper is replaced.
		[2] Clear BIOS User and Supervisor Passwords.
		See Section 3.7.4 Power Button Menu.

# 2.4 Mechanical Considerations

## 2.4.1 Form Factor

The board is designed to fit into a custom chassis. Figure 18 illustrates the mechanical form factor for the board. Dimensions are given in millimeters. The outer dimensions are 101.60 millimeters by 101.60 millimeters [4.0 inches by 4.0 inches].

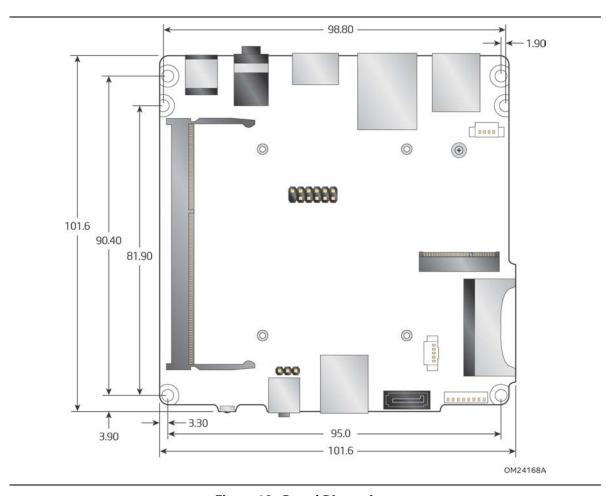


Figure 18. Board Dimensions

Figure 19 shows the height dimensions of the board.



Figure 19. Board Height Dimensions

#### **Electrical Considerations** 2.5

#### **Power Supply Considerations** 2.5.1

System power requirements will depend on actual system configurations chosen by the integrator, as well as end user expansion preferences. It is the system integrator's responsibility to ensure an appropriate power budget for the system configuration is properly assessed based on the system-level components chosen.

#### 2.5.2 **Fan Header Current Capability**

Table 21 lists the current capability of the fan header.

Table 21. Fan Header Current Capability

Fan Header	Maximum Available Current
Processor fan	.25 A

#### **Thermal Considerations** 2.6



# **A** CAUTION

A chassis with a maximum internal ambient temperature of 58 °C at the processor fan inlet is recommended. If the internal ambient temperature exceeds 58 °C, further thermal testing is required to ensure components do not exceed their maximum case temperature.



# **L** CAUTION

Failure to ensure appropriate airflow may result in reduced performance of both the processor and/or voltage regulator or, in some instances, damage to the board.

All responsibility for determining the adequacy of any thermal or system design remains solely with the system integrator. Intel makes no warranties or representations that merely following the instructions presented in this document will result in a system with adequate thermal performance.



# **A** CAUTION

Ensure that the ambient temperature does not exceed the board's maximum operating temperature. Failure to do so could cause components to exceed their maximum case temperature and malfunction. For information about the maximum operating temperature, see the environmental specifications in Section 2.8.



# **A** CAUTION

The processor voltage regulator area (shown in Figure 20) can reach a temperature of up to 97.5 °C in an open chassis. Ensure that proper airflow is maintained in the processor voltage regulator circuit. Failure to do so may result in shorter than expected product lifetime.

Figure 20 shows the locations of the localized high temperature zones.

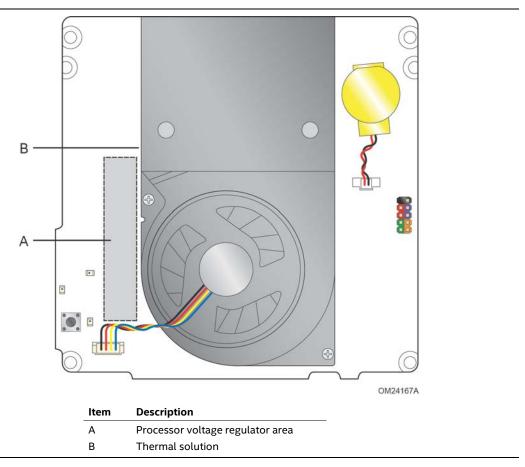


Figure 20. Localized High Temperature Zones

Table 22 provides maximum case temperatures for the components that are sensitive to thermal changes. The operating temperature, current load, or operating frequency could affect case temperatures. Maximum case temperatures are important when considering proper airflow to cool the board.

**Table 22. Thermal Considerations for Components** 

Component	Maximum Case Temperature	
Processor	For processor case temperature, see processor datasheets and processor specification updates	

To ensure functionality and reliability, the component is specified for proper operation when Case Temperature is maintained at or below the maximum temperature listed in Table 23. This is a requirement for sustained power dissipation equal to Thermal Design Power (TDP is specified as the maximum sustainable power to be dissipated by the components). When the component is dissipating less than TDP, the case temperature should be below the Maximum Case Temperature. The surface temperature at the geometric center of the component corresponds to Case Temperature.

It is important to note that the temperature measurement in the system BIOS is a value reported by embedded thermal sensors in the components and does not directly correspond to the Maximum Case Temperature. The upper operating limit when monitoring this thermal sensor is Tcontrol.

**Table 23. Tcontrol Values for Components** 

Component	Tcontrol
Processor	For processor case temperature, see processor datasheets and processor specification updates

For information about	Refer to
Processor datasheets and specification updates	Section 1.2, page 20

# 2.7 Reliability

The Mean Time Between Failures (MTBF) prediction is calculated using component and subassembly random failure rates. The calculation is based on the Telcordia SR-332-2 Issue 2, Method I, Case 3,  $55\,^{\circ}$ C ambient. The MTBF prediction is used to estimate repair rates and spare parts requirements. The MTBF for the board is 61,684 hours.

# 2.8 Environmental

Table 24 lists the environmental specifications for the board.

**Table 24. Environmental Specifications** 

Parameter	Specification		
Temperature			
Non-Operating	-40 °C to +60 °C		
Operating	0 °C to +50 °C		
	The operating temperature of the board may be determined by measuring the air temperature from the junction of the heatsink fins and fan, next to the attachment screw, in a closed chassis, while the system is in operation.		
Shock			
Unpackaged	50 g trapezoidal waveform		
	Velocity change of 170 inches/s <sup>2</sup>		
Packaged	Half sine 2 millisecond		
	Product Weight (pounds)	Free Fall (inches)	Velocity Change (inches/s²)
	<20	36	167
	21-40	30	152
	41-80	24	136
	81-100	18	118
Vibration		•	1
Unpackaged	5 Hz to 20 Hz: 0.01 g <sup>2</sup> Hz sloping up to 0.02 g <sup>2</sup> Hz		
	20 Hz to 500 Hz: 0.02 g <sup>2</sup> Hz (flat)		
Packaged	5 Hz to 40 Hz: 0.015 g <sup>2</sup> Hz (flat)		
	40 Hz to 500 Hz: 0.015 g <sup>2</sup> Hz sloping down to 0.00015 g <sup>2</sup> Hz		

Note: Before attempting to operate this board, the overall temperature of the board must be above the minimum operating temperature specified. It is recommended that the board temperature be at least room temperature before attempting to power on the board. The operating and non-operating environment must avoid condensing humidity.

# 3 Overview of BIOS Features

## 3.1 Introduction

The board uses an Intel Visual BIOS that is stored in the Serial Peripheral Interface Flash Memory (SPI Flash) and can be updated using a disk-based program. The SPI Flash contains the Visual BIOS Setup program, POST, the PCI auto-configuration utility, LAN EEPROM information, and Plug and Play support. The initial production BIOSs are identified as PYBSW10H.86A.

The Visual BIOS Setup program can be used to view and change the BIOS settings for the computer, and to update the system BIOS. The BIOS Setup program is accessed by pressing the <F2> key after the Power-On Self-Test (POST) memory test begins and before the operating system boot begins.



#### NOTE

The maintenance menu is displayed only when the board is in configuration mode. Section 2.3 on page 52 shows how to put the board in configuration mode.

# 3.2 BIOS Flash Memory Organization

The Serial Peripheral Interface Flash Memory (SPI Flash) includes a 64 Mb (8192 KB) flash memory device.

# 3.3 System Management BIOS (SMBIOS)

SMBIOS is a Desktop Management Interface (DMI) compliant method for managing computers in a managed network.

The main component of SMBIOS is the Management Information Format (MIF) database, which contains information about the computing system and its components. Using SMBIOS, a system administrator can obtain the system types, capabilities, operational status, and installation dates for system components. The MIF database defines the data and provides the method for accessing this information. The BIOS enables applications such as third-party management software to use SMBIOS. The BIOS stores and reports the following SMBIOS information:

- BIOS data, such as the BIOS revision level
- Fixed-system data, such as peripherals, serial numbers, and asset tags
- Resource data, such as memory size, cache size, and processor speed
- Dynamic data, such as event detection and error logging

Non-Plug and Play operating systems require an additional interface for obtaining the SMBIOS information. The BIOS supports an SMBIOS table interface for such operating systems. Using this support, an SMBIOS service-level application running on a non-Plug and Play operating system

can obtain the SMBIOS information. Additional board information can be found in the BIOS under the Additional Information header under the Main BIOS page.

# 3.4 Legacy USB Support

Legacy USB support enables USB devices to be used even when the operating system's USB drivers are not yet available. Legacy USB support is used to access the BIOS Setup program, and to install an operating system that supports USB. By default, Legacy USB support is set to Enabled.

Legacy USB support operates as follows:

- 1. When you apply power to the computer, legacy support is disabled.
- 2. POST begins.
- 3. Legacy USB support is enabled by the BIOS allowing you to use a USB keyboard to enter and configure the BIOS Setup program and the maintenance menu.
- 4. POST completes.
- 5. The operating system loads. While the operating system is loading, USB keyboards and mice are recognized and may be used to configure the operating system. (Keyboards and mice are not recognized during this period if Legacy USB support was set to Disabled in the BIOS Setup program.)
- 6. After the operating system loads the USB drivers, all legacy and non-legacy USB devices are recognized by the operating system, and Legacy USB support from the BIOS is no longer used.
- 7. Additional USB legacy feature options can be access by using Intel® Integrator Toolkit.

To install an operating system that supports USB, verify that Legacy USB support in the BIOS Setup program is set to Enabled and follow the operating system's installation instructions.

# 3.5 BIOS Updates

The BIOS can be updated using either of the following utilities, which are available on the Intel World Wide Web site:

- Intel® Express BIOS Update utility, which enables automated updating while in the Windows environment. Using this utility, the BIOS can be updated from a file on a hard disk, a USB drive (a flash drive or a USB hard drive), or a CD-ROM, or from the file location on the Web.
- Intel\* Flash Memory Update Utility, which requires booting from DOS. Using this utility, the BIOS can be updated from a file on a hard disk, a USB drive (a flash drive or a USB hard drive), or a CD-ROM.
- Intel F7 switch during POST allows a user to select where the BIOS .bio file is located and perform the update from that location/device. Similar to performing a BIOS Recovery without removing the BIOS configuration jumper.
- Intel Visual BIOS allows the user to select the BIOS .bio file from the internet, USB device, hard disk drive, or other media.

All utilities verify that the updated BIOS matches the target system to prevent accidentally installing an incompatible BIOS.



#### NOTE

Review the instructions distributed with the upgrade utility before attempting a BIOS update.

For information about	Refer to
BIOS update utilities	http://www.intel.com/support/motherboards/desktop/sb/CS-034499.htm

# 3.5.1 Language Support

The BIOS Setup program and help messages are supported in US English. Check the Intel web site for support.

## 3.5.2 Custom Splash Screen

During POST, an Intel® splash screen is displayed by default. This splash screen can be augmented with a custom splash screen. The Intel Integrator's Toolkit that is available from Intel can be used to create a custom splash screen.



#### **NOTE**

If you add a custom splash screen, it will share space with the Intel branded logo.

For information about	Refer to
Intel Integrator Toolkit	http://developer.intel.com/design/motherbd/software/itk/
Additional Intel® software tools	http://developer.intel.com/design/motherbd/software.htm

# 3.6 BIOS Recovery

It is unlikely that anything will interrupt a BIOS update; however, if an interruption occurs, the BIOS could be damaged. Table 25 lists the drives and media types that can and cannot be used for BIOS recovery. The BIOS recovery media does not need to be made bootable.

Table 25. Acceptable Drives/Media Types for BIOS Recovery

Media Type (Note)	Can be used for BIOS recovery?	
Hard disk drive (connected to SATA or USB)	Yes	
CD/DVD drive (connected to SATA or USB)	Yes	
USB flash drive	Yes	
USB diskette drive (with a 1.4 MB diskette)	No (BIOS update file is bigger than 1.4 MB size limit)	



#### NOTE

Supported file systems for BIOS recovery:

- NTFS (sparse, compressed, or encrypted files are not supported)
- FAT32
- FAT16

- FAT12
- ISO 9660

For information about	Refer to
BIOS recovery	http://www.intel.com/support/motherboards/desktop/sb/CS-034524.htm

# 3.7 Boot Options

In the BIOS Setup program, the user can choose to boot from a hard drive, optical drive, removable drive, or the network. The default setting is for the optical drive to be the first boot device, the hard drive second, removable drive third, and the network fourth.

#### 3.7.1 Network Boot

The network can be selected as a boot device. This selection allows booting from the onboard LAN or a network add-in card with a remote boot ROM installed.

Pressing the <F12> key during POST automatically forces booting from the LAN. To use this key during POST, the User Access Level in the BIOS Setup program's Security menu must be set to Full.

## 3.7.2 Booting Without Attached Devices

For use in embedded applications, the BIOS has been designed so that after passing the POST, the operating system loader is invoked even if the following devices are not present:

- Video adapter
- Keyboard
- Mouse

# 3.7.3 Changing the Default Boot Device During POST

Pressing the <F10> key during POST causes a boot device menu to be displayed. This menu displays the list of available boot devices. Table 26 lists the boot device menu options.

**Table 26. Boot Device Menu Options** 

Boot Device Menu Function Keys	Description	
<^> or <↓>	Selects a default boot device	
<enter></enter>	Exits the menu, and boots from the selected device	
<esc></esc>	Exits the menu and boots according to the boot priority defined through BIOS setup	

#### 3.7.4 Power Button Menu

The Power Button Menu is accessible via the following sequence:

- 1. System is in S4/S5 (not G3)
- 2. User pushes the power button and holds it down
- 3. The system will emit three short beeps from the PC speaker or headphones if installed, then stop to signal the user to release the power button (approximately 3 seconds) or the power button LED to its alternate color. Release immediately.
- 4. User releases the power button before the 4-second shutdown override

If this boot path is taken, the BIOS will use default settings, ignoring settings in VPD where possible.

At the point where Setup Entry/Boot would be in the normal boot path, the BIOS will display the following prompt and wait for a keystroke:

- [ESC] Normal Boot
- [F2] Intel Visual BIOS
- [F3] Disable Fast Boot
- [F4] BIOS Recovery
- [F7] Update BIOS
- [F10] Enter Boot Menu
- [F12] Network Boot

[F3] Disable Fast Boot is only displayed if at least one Fast Boot optimization is enabled.

If an unrecognized key is hit, then the BIOS will beep and wait for another keystroke. If one of the listed hotkeys is hit, the BIOS will follow the indicated boot path. Password requirements must still be honored.

If Disable Fast Boot is selected, the BIOS will disable all Fast Boot optimizations and reset the system.

# 3.8 Hard Disk Drive Password Security Feature

The Hard Disk Drive Password Security feature blocks read and write accesses to the hard disk drive until the correct password is given. Hard Disk Drive Passwords are set in BIOS SETUP and are prompted for during BIOS POST. For convenient support of S3 resume, the system BIOS will automatically unlock drives on resume from S3. Valid password characters are A-Z, a-z, and 0-9. Passwords may be up to 19 characters in length.

The User hard disk drive password, when installed, will be required upon each power-cycle until the Master Key or User hard disk drive password is submitted.

The Master Key hard disk drive password, when installed, will not lock the drive. The Master Key hard disk drive password exists as an unlock override in the event that the User hard disk drive password is forgotten. Only the installation of the User hard disk drive password will cause a hard disk to be locked upon a system power-cycle.

Table 27 shows the effects of setting the Hard Disk Drive Passwords.

Table 27. Master Key and User Hard Drive Password Functions

Password Set	Password During Boot	
Neither	None	
Master only	None	
User only	User only	
Master and User Set	Master or User	

During every POST, if a User hard disk drive password is set, POST execution will pause with the following prompt to force the user to enter the Master Key or User hard disk drive password:

Enter Hard Disk Drive Password:

Upon successful entry of the Master Key or User hard disk drive password, the system will continue with normal POST.

If the hard disk drive password is not correctly entered, the system will go back to the above prompt. The user will have three attempts to correctly enter the hard disk drive password. After the third unsuccessful hard disk drive password attempt, the system will halt with the message:

Hard Disk Drive Password Entry Error

A manual power cycle will be required to resume system operation.



#### NOTE

The passwords are stored on the hard disk drive so if the drive is relocated to another computer that does not support Hard Disk Drive Password Security feature, the drive will not be accessible.

# 3.9 BIOS Security Features

The BIOS includes security features that restrict access to the BIOS Setup program and who can boot the computer. A supervisor password and a user password can be set for the BIOS Setup program and for booting the computer, with the following restrictions:

- The supervisor password gives unrestricted access to view and change all the Setup options in the BIOS Setup program. This is the supervisor mode.
- The user password gives restricted access to view and change Setup options in the BIOS Setup program. This is the user mode.
- If only the supervisor password is set, pressing the <Enter> key at the password prompt of the BIOS Setup program allows the user restricted access to Setup.
- If both the supervisor and user passwords are set, users can enter either the supervisor password or the user password to access Setup. Users have access to Setup respective to which password is entered.
- Setting the user password restricts who can boot the computer. The password prompt will be displayed before the computer is booted. If only the supervisor password is set, the computer boots without asking for a password. If both passwords are set, the user can enter either password to boot the computer.
- For enhanced security, use different passwords for the supervisor and user passwords.
- Valid password characters are A-Z, a-z, and 0-9. Passwords may be up to 20 characters in length.
- To clear a set password, enter a blank password after entering the existing password.

Table 28 shows the effects of setting the supervisor password and user password. This table is for reference only and is not displayed on the screen.

Table 28. Supervisor and User Password Functions

Password Set	Supervisor Mode	User Mode	Setup Options	Password to Enter Setup	Password During Boot
Neither	Can change all options <sup>(Note)</sup>	Can change all options (Note)	None	None	None
Supervisor only	Can change all options	Can change a limited number of options	Supervisor Password	Supervisor	None
User only	N/A	Can change all options	Enter Password Clear User Password	User	User
Supervisor and user set	Can change all options	Can change a limited number of options	Supervisor Password Enter Password	Supervisor or user	Supervisor or user

Note: If no password is set, any user can change all Setup options.

Intel NUC Board NUC5CPYB and Intel NUC Board NUC5PPYB Technical Product Specification

# 4 Error Messages and Blink Codes

# 4.1 Front-panel Power LED Blink Codes

Whenever a recoverable error occurs during POST, the BIOS causes the board's front panel power LED to blink an error message describing the problem (see Table 29).

Table 29. Front-panel Power LED Blink Codes

Туре	Pattern	Note
BIOS update in progress	Off when the update begins, then on for 0.5 seconds, then off for 0.5 seconds. The pattern repeats until the BIOS update is complete.	
Video error <sup>(Note)</sup>	On-off (1.0 second each) two times, then 2.5-second pause (off), entire pattern repeats (blink and pause) until the system is powered off.	When no VGA option ROM is found.
Memory error	On-off (1.0 second each) three times, then 2.5-second pause (off), entire pattern repeats (blinks and pause) until the system is powered off.	
Thermal trip warning	Each beep will be accompanied by the following blink pattern: .25 seconds on, .25 seconds off, .25 seconds on, .25 seconds off. This will result in a total of 16 blinks.	

Note: Disabled per default BIOS setup option.

# 4.2 BIOS Error Messages

Table 30 lists the error messages and provides a brief description of each.

Table 30. BIOS Error Messages

Error Message	Explanation	
CMOS Battery Low	The battery may be losing power. Replace the battery soon.	
CMOS Checksum Bad	The CMOS checksum is incorrect. CMOS memory may have been corrupted. Run Setup to reset values.	
Memory Size Decreased	Memory size has decreased since the last boot. If no memory was removed, then memory may be bad.	
No Boot Device Available	System did not find a device to boot.	

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# 5 Regulatory Compliance and Battery Disposal Information

# 5.1 Regulatory Compliance

This section contains the following regulatory compliance information for Intel NUC Board NUC5CPYB and Intel NUC Board NUC5PPYB:

- Safety standards
- European Union Declaration of Conformity statement
- Product Ecology statements
- Electromagnetic Compatibility (EMC) standards
- Product certification markings

# 5.1.1 Safety Standards

Intel NUC Board NUC5CPYB and Intel NUC Board NUC5PPYB comply with the safety standards stated in Table 31 when correctly installed in a compatible host system.

Table 31. Safety Standards

Standard	Title
CSA/UL 60950-1	Information Technology Equipment – Safety - Part 1: General Requirements (USA and Canada)
EN 60950-1	Information Technology Equipment – Safety - Part 1: General Requirements (European Union)
IEC 60950-1	Information Technology Equipment – Safety - Part 1: General Requirements (International)

## 5.1.2 European Union Declaration of Conformity Statement

We, Intel Corporation, declare under our sole responsibility that the products Intel NUC Board NUC5CPYB and Intel NUC Board NUC5PPYB are in conformity with all applicable essential requirements necessary for CE marking, following the provisions of the European Council Directive 2004/108/EC (EMC Directive), 2006/95/EC (Low Voltage Directive), and 2002/95/EC (ROHS Directive).

The product is properly CE marked demonstrating this conformity and is for distribution within all member states of the EU with no restrictions.



This product follows the provisions of the European Directives 2004/108/EC, 2006/95/EC, and 2002/95/EC.

**Čeština** Tento výrobek odpovídá požadavkům evropských směrnic 2004/108/EC, 2006/95/EC a 2002/95/EC.

**Dansk** Dette produkt er i overensstemmelse med det europæiske direktiv 2004/108/EC, 2006/95/EC & 2002/95/EC.

**Dutch** Dit product is in navolging van de bepalingen van Europees Directief 2004/108/EC, 2006/95/EC & 2002/95/EC.

**Eesti** Antud toode vastab Euroopa direktiivides 2004/108/EC, ja 2006/95/EC ja 2002/95/EC kehtestatud nõuetele.

**Suomi** Tämä tuote noudattaa EU-direktiivin 2004/108/EC, 2006/95/EC & 2002/95/EC määräyksiä.

*Français* Ce produit est conforme aux exigences de la Directive Européenne 2004/108/EC, 2006/95/EC & 2002/95/EC.

**Deutsch** Dieses Produkt entspricht den Bestimmungen der Europäischen Richtlinie 2004/108/EC, 2006/95/EC & 2002/95/EC.

**Ελληνικά** Το παρόν προϊόν ακολουθεί τις διατάξεις των Ευρωπαϊκών Οδηγιών 2004/108/ΕC, 2006/95/ΕC και 2002/95/ΕC.

*Magyar* E termék megfelel a 2004/108/EC, 2006/95/EC és 2002/95/EC Európai Irányelv előírásainak.

*Icelandic* Pessi vara stenst reglugerð Evrópska Efnahags Bandalagsins númer 2004/108/EC, 2006/95/EC, & 2002/95/EC.

*Italiano* Questo prodotto è conforme alla Direttiva Europea 2004/108/EC, 2006/95/EC & 2002/95/EC.

*Latviešu* Šis produkts atbilst Eiropas Direktīvu 2004/108/EC, 2006/95/EC un 2002/95/EC noteikumiem.

*Lietuvių* Šis produktas atitinka Europos direktyvų 2004/108/EC, 2006/95/EC, ir 2002/95/EC nuostatas.

*Malti* Dan il-prodott hu konformi mal-provvedimenti tad-Direttivi Ewropej 2004/108/EC, 2006/95/EC u 2002/95/EC.

**Norsk** Dette produktet er i henhold til bestemmelsene i det europeiske direktivet 2004/108/EC, 2006/95/EC & 2002/95/EC.

**Polski** Niniejszy produkt jest zgodny z postanowieniami Dyrektyw Unii Europejskiej 2004/108/EC, 206/95/EC i 2002/95/EC.

**Portuguese** Este produto cumpre com as normas da Diretiva Européia 2004/108/EC, 2006/95/EC & 2002/95/EC.

**Español** Este producto cumple con las normas del Directivo Europeo 2004/108/EC, 2006/95/EC & 2002/95/EC.

**Slovensky** Tento produkt je v súlade s ustanoveniami európskych direktív 2004/108/EC, 2006/95/EC a 2002/95/EC.

**Slovenščina** Izdelek je skladen z določbami evropskih direktiv 2004/108/EC, 2006/95/EC in 2002/95/EC.

**Svenska** Denna produkt har tillverkats i enlighet med EG-direktiv 2004/108/EC, 2006/95/EC & 2002/95/EC.

Türkçe Bu ürün, Avrupa Birliği'nin 2004/108/EC, 2006/95/EC ve 2002/95/EC yönergelerine uyar.

## 5.1.3 Product Ecology Statements

The following information is provided to address worldwide product ecology concerns and regulations.

## 5.1.3.1 Disposal Considerations

This product contains the following materials that may be regulated upon disposal: lead solder on the printed wiring board assembly.

# 5.1.4 EMC Regulations

Intel NUC Board NUC5CPYB and Intel NUC Board NUC5PPYB comply with the EMC regulations stated in Table 32 when correctly installed in a compatible host system.

**Table 32. EMC Regulations** 

Regulation	Title	
FCC 47 CFR Part 15, Subpart B	Title 47 of the Code of Federal Regulations, Part 15, Subpart B, Radio Frequency Devices. (USA)	
ICES-003	Interference-Causing Equipment Standard, Digital Apparatus. (Canada)	
EN55022	Limits and methods of measurement of Radio Interference Characteristics of Information Technology Equipment. (European Union)	
EN55024	Information Technology Equipment – Immunity Characteristics Limits and methods of measurement. (European Union)	
EN55022	Australian Communications Authority, Standard for Electromagnetic Compatibility. (Australia and New Zealand)	
CISPR 22	Limits and methods of measurement of Radio Disturbance Characteristics of Information Technology Equipment. (International)	
CISPR 24	Information Technology Equipment – Immunity Characteristics – Limits and Methods of Measurement. (International)	
VCCI V-3, V-4	Voluntary Control for Interference by Information Technology Equipment. (Japan)	
KN-22, KN-24	Korean Communications Commission – Framework Act on Telecommunications and	

# Intel NUC Board NUC5CPYB and Intel NUC Board NUC5PPYB Technical Product Specification

	Radio Waves Act (South Korea)
CNS 13438	Bureau of Standards, Metrology, and Inspection (Taiwan)

#### **FCC Declaration of Conformity**

This device complies with Part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) this device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

For questions related to the EMC performance of this product, contact:

Intel Corporation, 5200 N.E. Elam Young Parkway, Hillsboro, OR 97124 1-800-628-8686

This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to Part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and the receiver.
- Connect the equipment to an outlet on a circuit other than the one to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

Any changes or modifications to the equipment not expressly approved by Intel Corporation could void the user's authority to operate the equipment.

Tested to comply with FCC standards for home or office use.

#### **Canadian Department of Communications Compliance Statement**

This digital apparatus does not exceed the Class B limits for radio noise emissions from digital apparatus set out in the Radio Interference Regulations of the Canadian Department of Communications.

Le présent appareil numerique német pas de bruits radioélectriques dépassant les limites applicables aux appareils numériques de la classe B prescrites dans le Réglement sur le broullage radioélectrique édicté par le ministére des Communications du Canada.

#### **Japan VCCI Statement**

Japan VCCI Statement translation: This is a Class B product based on the standard of the Voluntary Control Council for Interference from Information Technology Equipment (VCCI). If this is used near a radio or television receiver in a domestic environment, it may cause radio interference. Install and use the equipment according to the instruction manual.

この装置は、情報処理装置等電波障害自主規制協議会 (VCCI) の基準に基づくクラスB情報技術装置です。この装置は、家庭環境で使用することを目的としていますが、この装置がラジオやテレビジョン受信機に近接して使用されると、受信障害を引き起こすことがあります。 取扱説明書に従って正しい取り扱いをして下さい。

#### **Korea Class B Statement**

Korea Class B Statement translation: This equipment is for home use, and has acquired electromagnetic conformity registration, so it can be used not only in residential areas, but also other areas.

이 기기는 가정용(B급) 전자파적합기기로서 주 로 가정에서 사용하는 것을 목적으로 하며, 모 든 지역에서 사용할 수 있습니다.

# 5.1.5 e-Standby and ErP Compliance

Intel NUC Board NUC5CPYB and Intel NUC Board NUC5PPYB meet the following program requirements in an adequate system configuration, including appropriate selection of an efficient power supply:

- EPEAT\*
- Korea e-Standby
- European Union Energy-related Products Directive 2013 (ErP) Lot 6

For information about	Refer to
Electronic Product Environmental Assessment Tool (EPEAT)	http://www.epeat.net/
Korea e-Standby Program	http://www.kemco.or.kr/new_eng/pg02/pg02100300 .asp
European Union Energy-related Products Directive 2009 (ErP)	http://ec.europa.eu/enterprise/policies/sustainable- business/sustainable-product- policy/ecodesign/index_en.htm

# 5.1.6 Regulatory Compliance Marks (Board Level)

Intel NUC Board NUC5CPYB and Intel NUC Board NUC5PPYB have the regulatory compliance marks shown in Table 33.

**Table 33. Regulatory Compliance Marks** 

Description	Mark
UL joint US/Canada Recognized Component mark. Includes adjacent UL file number for Intel NUC Boards: E210882.	c FLI® us
FCC Declaration of Conformity logo mark for Class B equipment.	F© CE
CE mark. Declaring compliance to the European Union (EU) EMC directive, Low Voltage directive, and RoHS directive.	
For CE Mark-Related Questions: Intel Corporation Attn: Corporate Quality 2200 Mission College Blvd. Santa Clara, CA 95054-1549 USA	
Australian Communications Authority (ACA) and New Zealand Radio Spectrum Management (NZ RSM) C-tick mark. Includes adjacent Intel supplier code number, N-232.	
Japan VCCI (Voluntary Control Council for Interference) mark.	<b>V</b> €I
Korea Certification mark. Includes an adjacent KCC (Korean Communications Commission) certification number: KCC-REM-CPU-NUC5CPY and KCC-REM-CPU-NUC5PPY.	
Taiwan BSMI (Bureau of Standards, Metrology and Inspections) mark. Includes adjacent Intel company number, D33025.	€
Printed wiring board manufacturer's recognition mark. Consists of a unique UL recognized manufacturer's logo, along with a flammability rating (solder side).	V-0
China RoHS/Environmentally Friendly Use Period Logo: This is an example of the symbol used on Intel NUC Boards and associated collateral. The color of the mark may vary depending upon the application. The Environmental Friendly Usage Period (EFUP) for Intel NUC Boards has been determined to be 10 years.	10)

#### **Battery Disposal Information** 5.2



# CAUTION

Risk of explosion if the battery is replaced with an incorrect type. Batteries should be recycled where possible. Disposal of used batteries must be in accordance with local environmental regulations.



# PRÉCAUTION

Risque d'explosion si la pile usagée est remplacée par une pile de type incorrect. Les piles usagées doivent être recyclées dans la mesure du possible. La mise au rebut des piles usagées doit respecter les réglementations locales en vigueur en matière de protection de l'environnement.



# FORHOLDSREGEL

Eksplosionsfare, hvis batteriet erstattes med et batteri af en forkert type. Batterier bør om muligt genbruges. Bortskaffelse af brugte batterier bør foregå i overensstemmelse med gældende miljølovgivning.



# OBS!

Det kan oppstå eksplosjonsfare hvis batteriet skiftes ut med feil type. Brukte batterier bør kastes i henhold til gjeldende miljølovgivning.



## VIKTIGT!

Risk för explosion om batteriet ersätts med felaktig batterityp. Batterier ska kasseras enligt de lokala miljövårdsbestämmelserna.



# 🖺 VARO

Räjähdysvaara, jos pariston tyyppi on väärä. Paristot on kierrätettävä, jos se on mahdollista. Käytetyt paristot on hävitettävä paikallisten ympäristömääräysten mukaisesti.



# 🔼 vorsicht

Bei falschem Einsetzen einer neuen Batterie besteht Explosionsgefahr. Die Batterie darf nur durch denselben oder einen entsprechenden, vom Hersteller empfohlenen Batterietyp ersetzt werden. Entsorgen Sie verbrauchte Batterien den Anweisungen des Herstellers entsprechend.



# **AVVERTIMENTO**

Esiste il pericolo di un esplosione se la pila non viene sostituita in modo corretto. Utilizzare solo pile uguali o di tipo equivalente a quelle consigliate dal produttore. Per disfarsi delle pile usate, seguire le istruzioni del produttore.



# \Lambda PRECAUCIÓN

Existe peligro de explosión si la pila no se cambia de forma adecuada. Utilice solamente pilas iguales o del mismo tipo que las recomendadas por el fabricante del equipo. Para deshacerse de las pilas usadas, siga igualmente las instrucciones del fabricante.



# WAARSCHUWING

Er bestaat ontploffingsgevaar als de batterij wordt vervangen door een onjuist type batterij. Batterijen moeten zoveel mogelijk worden gerecycled. Houd u bij het weggooien van gebruikte batterijen aan de plaatselijke milieuwetgeving.



# 🔼 ATENÇÃO

Haverá risco de explosão se a bateria for substituída por um tipo de bateria incorreto. As baterias devem ser recicladas nos locais apropriados. A eliminação de baterias usadas deve ser feita de acordo com as regulamentações ambientais da região.



# 🗥 AŚCIAROŽZNAŚĆ

Існуе рызыка выбуху, калі заменены акумулятар неправільнага тыпу. Акумулятары павінны, па магчымасці, перепрацоўвацца. Пазбаўляцца ад старых акумулятараў патрэбна згодна з мясцовым заканадаўствам па экалогіі.



# UPOZORNÌNÍ

V případě výměny baterie za nesprávný druh může dojít k výbuchu. Je-li to možné, baterie by měly být recyklovány. Baterie je třeba zlikvidovat v souladu s místními předpisy o životním prostředí.



# 🔼 Προσοχή

Υπάρχει κίνδυνος για έκρηξη σε περίπτωση που η μπαταρία αντικατασταθεί από μία λανθασμένου τύπου. Οι μπαταρίες θα πρέπει να ανακυκλώνονται όταν κάτι τέτοιο είναι δυνατό. Η απόρριψη των χρησιμοποιημένων μπαταριών πρέπει να γίνεται σύμφωνα με τους κατά τόπο περιβαλλοντικούς κανονισμούς.



# VIGYÁZAT

Ha a telepet nem a megfelelő típusú telepre cseréli, az felrobbanhat. A telepeket lehetőség szerint újra kell hasznosítani. A használt telepeket a helyi környezetvédelmi előírásoknak megfelelően kell kiselejtezni.



異なる種類の微池を使用すると、繊鉛の危険があります。リサイクル が可動な地域であれば、微熱をリサイクルしてください。使用級の微 **池を破棄する際には、地域の環境推制に集ってください。** 



#### AWAS

Risiko letupan wujud jika bateri digantikan dengan jenis yang tidak betul. Bateri sepatutnya dikitar semula jika boleh. Pelupusan bateri terpakai mestilah mematuhi peraturan alam sekitar tempatan.



# OSTRZEŻENIE

Istnieje niebezpieczeństwo wybuchu w przypadku zastosowania niewłaściwego typu baterii. Zużyte baterie należy w miarę możliwości utylizować zgodnie z odpowiednimi przepisami ochrony środowiska.



## PRECAUTIE

Risc de explozie, dacă bateria este înlocuită cu un tip de baterie necorespunzător. Bateriile trebuie reciclate, dacă este posibil. Depozitarea bateriilor uzate trebuie să respecte reglementările locale privind protecția mediului.



# <u> В</u>

При использовании батареи несоответствующего типа существует риск ее взрыва. Батареи должны быть утилизированы по возможности. Утилизация батарей должна проводится по правилам, соответствующим местным требованиям.



# UPOZORNENIE

Ak batériu vymeníte za nesprávny typ, hrozí nebezpečenstvo jej výbuchu. Batérie by sa mali podľa možnosti vždy recyklovať. Likvidácia použitých batérií sa musí vykonávať v súlade s miestnymi predpismi na ochranu životného prostredia.



## POZOR

Zamenjava baterije z baterijo drugačnega tipa lahko povzroči eksplozijo. Če je mogoče, baterije reciklirajte. Rabljene baterije zavrzite v skladu z lokalnimi okoljevarstvenimi predpisi.



#### คำเตือน

ระวังการระเบิดที่เกิดจากเปลี่ยนแบตเตอรี่ผิดประเภท หากเป็นไปได้ ควรนำแบตเตอรี่ไปรีไซเคิล การ ทิ้งแบตเตอรี่ใช้แล้วต้องเป็นไปตามกฎข้อบังคับด้านสิ่งแวดล้อมของท้องถิ่น.



#### 🔼 UYARI

Yanlış türde pil takıldığında patlama riski vardır. Piller mümkün olduğunda geri dönüştürülmelidir. Kullanılmış piller, yerel çevre yasalarına uygun olarak atılmalıdır.



# 🔼 ОСТОРОГА

Використовуйте батареї правильного типу, інакше існуватиме ризик вибуху. Якщо можливо, використані батареї слід утилізувати. Утилізація використаних батарей має бути виконана згідно місцевих норм, що регулюють охорону довкілля.



# 🔔 upozornění

V případě výměny baterie za nesprávný druh může dojít k výbuchu. Je-li to možné, baterie by měly být recyklovány. Baterie je třeba zlikvidovat v souladu s místními předpisy o životním prostředí.



# ETTEVAATUST

Kui patarei asendatakse uue ebasobivat tüüpi patareiga, võib tekkida plahvatusoht. Tühjad patareid tuleb võimaluse korral viia vastavasse kogumispunkti. Tühjade patareide äraviskamisel tuleb järgida kohalikke keskkonnakaitse alaseid reegleid.



# FIGYELMEZTETÉS

Ha az elemet nem a megfelelő típusúra cseréli, felrobbanhat. Az elemeket lehetőség szerint újra kell hasznosítani. A használt elemeket a helyi környezetvédelmi előírásoknak megfelelően kell kiseleitezni.



# 🖺 uzmanību

Pastāv eksplozijas risks, ja baterijas tiek nomainītas ar nepareiza veida baterijām. Ja iespējams, baterijas vajadzētu nodot attiecīgos pieņemšanas punktos. Bateriju izmešanai atkritumos jānotiek saskaņā ar vietējiem vides aizsardzības noteikumiem.



## DĖMESIO

Naudojant netinkamo tipo baterijas įrenginys gali sprogti. Kai tik įmanoma, baterijas reikia naudoti pakartotinai. Panaudotas baterijas išmesti būtina pagal vietinius aplinkos apsaugos nuostatus.



#### ATTENZJONI

Riskiu ta' splużioni jekk il-batterija tinbidel b'tip ta' batterija mhux korrett. Il-batteriji għandhom jiġu riċiklati fejn hu possibbli. Ir-rimi ta' batteriji użati għandu jsir skond ir-regolamenti ambjentali lokali.



## OSTRZEŻENIE

Ryzyko wybuchu w przypadku wymiany na baterie niewłaściwego typu. W miarę możliwości baterie należy poddać recyklingowi. Zużytych baterii należy pozbywać się zgodnie z lokalnie obowiązującymi przepisami w zakresie ochrony środowiska.

Regulatory Compliance and Battery Disposal Information